19-0858; Rev 1; 1/10

EVALUATION KIT AVAILABLE

## High-Power, Quad, PSE Controller for Power-Over-Ethernet

## **General Description**

The MAX5952 is a quad -48V power controller designed for use in IEEE<sup>®</sup> 802.3af-compliant/pre-IEEE 802.3at-compatible power-sourcing equipment (PSE). This device provides powered device (PD) discovery, classification, current limit, DC and AC load disconnect detections in compliance with the IEEE 802.3af standard. The MAX5952 is pin compatible with MAX5945/LTC4258/LTC4259A PSE controllers and provides additional features.

The MAX5952 features high-power mode that provides up to 45W per port. The MAX5952 provides instantaneous readout of each port current through the I<sup>2</sup>C interface. The MAX5952 also provides high-capacitance detection for legacy PDs.

The device features an I<sup>2</sup>C-compatible, 3-wire serial interface, and is fully software configurable and programmable. The class-overcurrent detection function enables system power management to detect if a PD draws more than the allowable current. The MAX5952's extensive programmability enhances system flexibility, enables field diagnosis, and allows for uses in other applications.

The MAX5952 provides four operating modes to suit different system requirements. Auto mode allows the device to operate automatically without any software supervision. Semi-automatic mode automatically detects and classifies a device connected to a port after initial software activation, but does not power up that port until instructed to by software. Manual mode allows total software control of the device and is useful for system diagnostics. Shutdown mode terminates all activities and securely turns off power to the ports.

The MAX5952 provides input undervoltage lockout (UVLO), input undervoltage detection, input overvoltage lockout, overtemperature detection, output voltage slew-rate limit during startup, power-good status, and fault status. The MAX5952's programmability includes startup timeout, overcurrent timeout, and load-disconnect detection timeout.

The MAX5952 is available in a 36-pin SSOP package and is rated for both extended (-40°C to  $+85^{\circ}$ C) and upper commercial (0°C to  $+85^{\circ}$ C) temperature ranges.

## **Applications**

Power-Sourcing Equipment (PSE) Switches/Routers Midspan Power Injectors

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**Features** 

- IEEE 802.3af Compliant/Pre-IEEE 802.3at Compatible
- Instantaneous Readout of Port Current Through I<sup>2</sup>C Interface
- High-Power Mode Enables Up to 45W Per Port
- ♦ High-Capacitance Detection for Legacy Devices
- Pin Compatible to MAX5945 and LTC4258/LTC4259A
- Four Independent Power-Switch Controllers
- PD Detection and Classification
- Supports Both DC and AC Load Removal Detections
- ♦ I<sup>2</sup>C-Compatible, 3-Wire Serial Interface
- Current Foldback and Duty-Cycle-Controlled Current Limit
- ♦ Open-Drain INT Signal
- Direct Fast Shutdown Control Capability

## **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX5952AEAX+*	-40°C to +85°C	36 SSOP
MAX5952AUAX+	0°C to +85°C	36 SSOP
MAX5952CEAX+*	-40°C to +85°C	36 SSOP
MAX5952CUAX+*	0°C to +85°C	36 SSOP

+Denotes a lead(Pb)-free/RoHS-compliant package. \*Future product—contact factory for availability.

Pin Configuration and Selector Guide appear at end of data sheet.

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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

## **ABSOLUTE MAXIMUM RATINGS**

(Voltages referenced to V <sub>EE</sub> , unless otherwise noted.) AGND, DGND, DET_, V <sub>DD</sub> , RESET, A3-A0, SHD_, OSC,	
SCL, SDAIN, and AUTO0.3V to +	80V
OUT12V to (AGND + 0	.3V)
GATE_ (internally clamped) (Note 1)0.3V to +11	.4V
SENSE0.3V to +	24V
V <sub>DD</sub> , RESET, MIDSPAN, A3–A0, SHD_, OSC, SCL,	
SDAIN and AUTO to DGND0.3V to -	+7V
INT and SDAOUT to DGND0.3V to +	12V
AGND to DGND0.3V to -	+7V

Maximum Current into INT, SDAOUT, DET	80mA
Maximum Power Dissipation ( $T_A = +70^{\circ}C$ )	
36-Pin SSOP (derate 11.4mW/°C above	+70°C)941mW
Operating Temperature Ranges:	
MAX5952_EAX	40°C to +85°C
MAX5952_UAX	0°C to +85°C
Storage Temperature Range	65°C to +150°C
Junction Temperature	+150°C
Lead Temperature (soldering, 10s)	+300°C

Note 1: GATE\_ is internally clamped to 11.4V above VEE. Driving GATE\_ higher than 11.4V above VEE may damage the device.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

 $(V_{AGND} = 32V \text{ to } 60V, V_{EE} = 0V, V_{DD} \text{ to } V_{DGND} = +3.3V, \text{ all voltages are referenced to } V_{EE}, \text{ unless otherwise noted. Typical values are at } V_{AGND} = +48V, V_{DGND} = +48V, V_{DD} = (V_{DGND} + 3.3V), T_A = +25^{\circ}C.$  Currents are positive when entering the pin and negative otherwise.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS		
POWER SUPPLIES								
	Vagnd	VAGND - VEE	32		60			
Operating Voltage Papas	Vdgnd		0		60	V		
Operating voltage Range		$V_{DD}$ to $V_{DGND}$ , $V_{DGND} = V_{AGND}$	1.71		5.50	V		
	VDD	$V_{DD}$ to $V_{DGND}$ , $V_{DGND} = V_{EE}$	3.0		5.5			
Supply Currents	IEE	$V_{OUT}$ = VEE, VSENSE_ = VEE, DET_ = AGND, all logic inputs open, SCL = SDAIN = V <sub>DD</sub> . INT and SDAOUT open. Measured at AGND in power mode after GATE_ pullup		4.8	6.8	mA		
	IDIG	All logic inputs high, measured at $V_{\mbox{\scriptsize DD}}$		3.0	5.6			
GATE DRIVER AND CLAMPING								
GATE_ Pullup Current	IPU	Power mode, gate drive on, VGATE = VEE	-40	-50	-60	μA		
Weak GATE_ Pulldown Current	IPDW	$\overline{\text{SHD}}$ = DGND, $V_{\text{GATE}}$ = $V_{\text{EE}}$ + 10V	30	42	55	μA		
Maximum Pulldown Current	IPDS	VSENSE = 600mV, VGATE_ = VEE + 2V		70		mA		
External Gate Drive	VGS	VGATE - VEE, power mode, gate drive on		10	11	V		

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AGND} = 32V \text{ to } 60V, V_{EE} = 0V, V_{DD} \text{ to } V_{DGND} = +3.3V, \text{ all voltages are referenced to } V_{EE}, \text{ unless otherwise noted. Typical values are at } V_{AGND} = +48V, V_{DGND} = +48V, V_{DD} = (V_{DGND} + 3.3V), T_A = +25^{\circ}C$ . Currents are positive when entering the pin and negative otherwise.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
CURRENT LIMIT							
			IVEE = 00	202	212	220	
		Maximum V <sub>SENSE</sub> _allowed	IVEE = 01	192	202	212	
Current-Limit Clamp Voltage	Vsu_lim	during current limit, $V_{OUT} = 0V$ (ICUT = 000) (Note 3)	IVEE = 10	186	190	200	mV
			IVEE = 11	170	180	190	
			ICUT = 000 (Class 0/3)	177	186	196	
			ICUT =110 (Class 1)	47	55	62	
Overcurrent Threshold After Startup	VFLTTIM	Overcurrent V <sub>SENSE</sub> threshold allowed for $t \le t_{FAULT}$ after startup; V <sub>OUT</sub> = 0V, (IVEE = 00)	ICUT = 111 (Class 2)	86	94	101	mV
	_		ICUT = 001	265	280	295	
			ICUT = 010	310	327	345	
			ICUT = 011	355	374	395	
			ICUT = 100	398	419	440	
			ICUT =101	443	466	488	
Foldback Initial OUT_ Voltage	VFLBK_ST	V <sub>OUT</sub> - V <sub>EE</sub> , above which the current-limit trip voltage starts folding back, IVEE = 00	ICUT = 000, ICUT = 110, ICUT = 111		28		V
			ICUT = 001101		10		
Foldback Final OUT_ Voltage	VFLBK_END	IVEE = 00, ICUT = 000, V <sub>OUT</sub> - V which the current-limit trip voltag VTH_FB		50		V	
Minimum Foldback Current-Limit Threshold	V <sub>TH_FB</sub>	$V_{OUT} = V_{AGND} = 60V, IVEE = 0$	0, ICUT = 000		64		mV
SENSE_ Input Bias Current		$V_{SENSE} = V_{EE}$	-2		+2	μA	

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AGND} = 32V \text{ to } 60V, V_{EE} = 0V, V_{DD} \text{ to } V_{DGND} = +3.3V, all voltages are referenced to V_{EE}, unless otherwise noted. Typical values are at V_{AGND} = +48V, V_{DGND} = +48V, V_{DD} = (V_{DGND} + 3.3V), T_A = +25^{\circ}C$ . Currents are positive when entering the pin and negative otherwise.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS			ТҮР	MAX	UNITS	
SUPPLY MONITORS								
VEE Undervoltage Lockout	VEEUVLO	VAGND - VEE, VAGND - VEE incl	reasing		28.5		V	
V <sub>EE</sub> Undervoltage Lockout Hysteresis	VEEUVLOH	Ports shut down if V <sub>AGND</sub> - V <sub>EE</sub> VEEUVLOH	< Vuvlo -		3		V	
VEE Overvoltage Lockout	V <sub>EE_OV</sub>	V <sub>EE_OV</sub> event bit sets and port V <sub>AGND</sub> - V <sub>EE</sub> > V <sub>EE_OV</sub> , V <sub>AGND</sub>	s shut down if increasing		62.5		V	
V <sub>EE</sub> Overvoltage Lockout Hysteresis	V <sub>OVH</sub>				1		V	
VEE Undervoltage	V <sub>EE_UV</sub>	$V_{EE\_UV}$ event bit is set if $V_{AGND}$ $V_{EE}$ increasing	- $V_{EE} < V_{EE_UV}$ ,		40		V	
Var Overveltage		V <sub>DD_OV</sub> event bit is set if	MAX5952A		3.82		M	
VDD Overvoitage	VDD_OV	VDD - VDGND > VDD_OV; VDD increasing	MAX5952C		5.7		V	
		VDD OV is set if VDD - VDGND	MAX5952A		2.7			
V <sub>DD</sub> Undervoltage	VDD_UV	> V <sub>DD_UV</sub> , V <sub>DD</sub> decreasing	MAX5952C		4.2		V	
V <sub>DD</sub> Undervoltage Lockout	Vdduvlo	Device operates when V <sub>DD</sub> - V <sub>DGND</sub> > V <sub>DDUVLO</sub> , V <sub>DD</sub> increasing			2		V	
V <sub>DD</sub> Undervoltage Lockout Hysteresis	VDDHYS				120		mV	
Thermal Shutdown Threshold	T <sub>SHD</sub>	Ports shut down and device re junction temperature exceeds temperature increasing (Note 4	sets if its this limit, 1)		150		°C	
Thermal Shutdown Hysteresis	TSHDH	Thermal hysteresis, temperatur (Note 5)	e decreasing		20		°C	
OUTPUT MONITOR		•						
OUT_ Input Current	IBOUT	V <sub>OUT</sub> = V <sub>AGND</sub> , all modes				2	μA	
Idle Pullup Current at OUT_	IDIS	OUT_ discharge current, detection and classification off, port shutdown, V <sub>OUT</sub> _ = V <sub>AGND</sub> - 2.8V		200		260	μΑ	
PGOOD High Threshold	PGTH	VOUT VEE, OUT_ decreasing	1.5	2.0	2.5	V		
PGOOD Hysteresis	PGHYS				220		mV	
PGOOD Low-to-High Glitch Filter	tpgood	Minimum time PGOOD has to b bit in register 10h		3		ms		

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## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AGND} = 32V \text{ to } 60V, V_{EE} = 0V, V_{DD} \text{ to } V_{DGND} = +3.3V, \text{ all voltages are referenced to } V_{EE}, \text{ unless otherwise noted. Typical values are at } V_{AGND} = +48V, V_{DGND} = +48V, V_{DD} = (V_{DGND} + 3.3V), T_A = +25^{\circ}C.$  Currents are positive when entering the pin and negative otherwise.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS			TYP	MAX	UNITS
LOAD DISCONNECT							
DC Load Disconnect Threshold	V <sub>DCTH</sub>	Minimum V <sub>SENSE</sub> allowed (DC disconnect active), V	2.5	3.75	5.0	mV	
AC Load Disconnect Threshold (Note 6)	IACTH	Current into DET_, for I < powers off, ACD_EN_ bit	ElACTH the port E = H; V <sub>OSC_IN</sub> = 2.2V	300	320	350	μA
Oscillator Buffer Gain	A <sub>OSC</sub>	V <sub>DET_</sub> /V <sub>OSC</sub> , ACD_EN_ k	oit = H	2.9	3.0	3.1	V/V
OSC Fail Threshold (Note 7)	VOSC_FAIL	Port does not power on ir and ACD_EN_ bit is high	f Vosc < Vosc_fail	1.8		2.2	V
OSC Input Impedance	Z <sub>OSC</sub>	OSC input impedance w are active	hen all the ACD_EN_	100			kΩ
Load Disconnect Timer	tDISC	Time from V <sub>SENSE</sub> < V <sub>DC</sub> (Note 8)	<sub>TH</sub> to gate shutdown	300		400	ms
DETECTION							
Detection Probe Voltage (First Phase)	V <sub>DPH1</sub>	V <sub>AGND</sub> - V <sub>DET</sub> during th phase	e first detection	3.8	4	4.2	V
Detection Probe Voltage (Second Phase)	V <sub>DPH2</sub>	V <sub>AGND</sub> - V <sub>DET</sub> during th phase	9.0	9.3	9.6	V	
Current-Limit Protection	IDLIM	V <sub>DET_</sub> = V <sub>AGND</sub> , during of current through DET_	1.5	1.75	2.0	mA	
Short-Circuit Threshold	V <sub>DCP</sub>	If V <sub>AGND</sub> - V <sub>OUT</sub> < V <sub>DCP</sub> detection phase a short detected		1		V	
Open-Circuit Threshold	ID_OPEN	First point measurement open condition	current threshold for		12.5		μA
Resistor Detection Window	RDOK	(Note 9)		19.0		26.5	kΩ
Resistor Rejection Window	Rodad	Detection rejects lower v	alues			15.2	kO
	UDAD	Detection rejects higher	values	32			1/22
CLASSIFICATION		1					
Classification Probe Voltage	VCL	VAGND - VDET_ during classification		16		20	V
Current-Limit Protection	ICILIM	DET_ = AGND, during classification, measure current through DET_		68		81	mA
			Class 0, Class 1	5.5	6.5	7.5	
		Classification current	Class 1, Class 2	13	14.5	16	
Thresholds	ICL	thresholds between	Class 2, Class 3	21	23	25	mA
		classes	Class 3, Class 4	31	33	35	-
			Class 4, Class 5		48	51	

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AGND} = 32V \text{ to } 60V, V_{EE} = 0V, V_{DD} \text{ to } V_{DGND} = +3.3V, \text{ all voltages are referenced to } V_{EE}, \text{ unless otherwise noted. Typical values are at } V_{AGND} = +48V, V_{DGND} = +48V, V_{DD} = (V_{DGND} + 3.3V), T_A = +25^{\circ}C.$  Currents are positive when entering the pin and negative otherwise.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS			ТҮР	MAX	UNITS	
DIGITAL INPUTS/OUTPUTS (Referred to DGND)								
Digital Input Low	VIL					0.9	V	
Digital Input High	VIH			2.4			V	
Internal Input Pullup/Pulldown Resistor	R <sub>DIN</sub>	Pullup (pulldown) resistor to set default level	V <sub>DD</sub> (DGND) to	25	50	75	kΩ	
Open-Drain Output Low Voltage	V <sub>OL</sub>	ISINK = 15mA				0.4	V	
Digital Input Leakage	I <sub>DL</sub>	Input connected to the pull	voltage			2	μA	
Open-Drain Leakage	IOL	Open-drain high impedance	e, V <sub>O</sub> = 3.3V			2	μA	
TIMING								
Startup Time	<sup>t</sup> START	Time during which a current $V_{SU\_LIM}$ is allowed, starts w turned on (Note 5)	t limit set by hen the GATE_ is	50	60	70	ms	
Fault Time	<sup>t</sup> FAULT	Maximum allowed time for a condition set by VFLT_LIM at	an overcurrent fter startup (Note 5)	50	60	70	ms	
Port Turn-Off Time	toff	Minimum delay between an does not apply in case of a	Minimum delay between any port turning off, does not apply in case of a reset				ms	
Detection Reset Time		Time allowed for the port vo before detection starts	Time allowed for the port voltage to reset before detection starts			90	ms	
Detection Time	<sup>t</sup> DET	Maximum time allowed befor completed	Maximum time allowed before detection is completed			330	ms	
Midspan Mode Detection Delay	t <sub>DMID</sub>			2.0		2.4	S	
Classification Time	<b>t</b> CLASS	Time allowed for classificati	on		19	23	ms	
V <sub>EEUVLO</sub> Turn-On Delay	<sup>t</sup> DLY	Time V <sub>AGND</sub> must be above thresholds before the device	e the V <sub>EEUVLO</sub> e operates	2		4	ms	
			RSTR bits = 00		16 x tfault			
Restart Timer	<b>t</b> RESTART	Time a port has to wait before turning on after an	RSTR bits = 01		32 x <sup>t</sup> fault	32 x tfault		
		RSTR_EN_ bits = high	RSTR bits = 10	64 x <sup>t</sup> fault				
			RSTR bits = 11		0			
Watchdog Clock Period	twp	Rate of decrement of the wa		164		ms		
ADC PERFORMANCE								
Resolution					9		Bits	
Range					0.51		V	
LSB Step Size					1		mV	
Integral Nonlinearity (Relative)	INL				0.5		LSB	

## **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AGND} = 32V \text{ to } 60V, V_{EE} = 0V, V_{DD} \text{ to } V_{DGND} = +3.3V, \text{ all voltages are referenced to } V_{EE}, \text{ unless otherwise noted. Typical values are at } V_{AGND} = +48V, V_{DGND} = +48V, V_{DD} = (V_{DGND} + 3.3V), T_A = +25^{\circ}C.$  Currents are positive when entering the pin and negative otherwise.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
Differential Nonlinearity	DNL			0.1		LSB
		V <sub>SENSE</sub> = 100mV	5B (91)	62 (98)	68 (104)	
ADC Absolute Accuracy		V <sub>SENSE</sub> = 250mV	F0 (240)	FC (252)	108 (264)	Hex (Dec)
		V <sub>SENSE</sub> = 400mV	186 (390)	196 (406)	1A6 (422)	
TIMING CHARACTERISTICS (F	or 2-Wire Fa	st Mode, Note 10)				
Serial-Clock Frequency	fSCL				400	kHz
Bus Free Time Between a STOP and START Condition	<sup>t</sup> BUF		1.2			μs
Hold Time for a START Condition	<sup>t</sup> HD, STA		0.6			μs
Low Period of the SCL Clock	tLOW		1.2			μs
High Period of the SCL Clock	thigh		0.6			μs
Setup Time for a Repeated START Condition (Sr)	tsu, sta		0.6			μs
Data Hold Time	thd, dat		0		150	ns
Data in Setup Time	<sup>t</sup> SU, DAT		100			ns
Rise Time of Both SDA and SCL Signals, Receiving	tR		20 + 0.1C <sub>B</sub>		300	ns
Fall Time of SDA Transmitting	tF		20 + 0.1C <sub>B</sub>		300	ns
Setup Time for STOP Condition	tsu, sto		0.6			μs
Capacitive Load for Each Bus Line	Св				400	pF
Pulse Width of Spike Suppressed	tsp				50	ns

**Note 2:** Limits to  $T_A = -40^{\circ}C$  are guaranteed by design.

**Note 3:** Default values. The current-limit thresholds are programmed through the I<sup>2</sup>C-compatible serial interface (see the *Register Map and Description* section).

**Note 4:** Functional test is performed over thermal shutdown entering test mode.

**Note 5:** Default values. The startup and fault times can be also programmed through the I<sup>2</sup>C serial interface (see the *Register Map and Description* section).

Note 6: This is the default value. Threshold can be programmed through serial interface R23h[2:0].

**Note 7:** AC disconnect works only if  $(V_{DD} - V_{DGND}) \ge 3V$  and DGND is connected to AGND.

**Note 8**: t<sub>DISC</sub> can also be programmed through the serial interface (R16H) (see the *Register Map and Description* section).

**Note 9:**  $R_D = (V_{OUT_2} - V_{OUT_1}) / (I_{DET_2} - I_{DET_1})$ .  $V_{OUT_1}$ ,  $V_{OUT_2}$ ,  $I_{DET_2}$  and  $I_{DET_1}$  represent the voltage at OUT\_ and the current at DET\_ during phase 1 and 2 of the detection.

Note 10: Guaranteed by design. Not subject to production testing.

## **Typical Operating Characteristics**

(VEE = -48V, VDD = +3.3V, VAUTO = VAGND = VDGND = 0V, RESET = SHD\_ = unconnected, RSENSE = 0.5Ω, IVEE = 00, ICUT = 000,  $T_A = +25^{\circ}C$ , all registers = default setting, unless otherwise noted.)





 $(V_{EE} = -48V, V_{DD} = +3.3V, V_{AUTO} = V_{AGND} = V_{DGND} = 0V, \overline{RESET} = \overline{SHD}$  = unconnected,  $R_{SENSE} = 0.5\Omega$ , IVEE = 00, ICUT = 000,  $T_A = +25^{\circ}C$ , all registers = default setting, unless otherwise noted.)



## **Typical Operating Characteristics (continued)**

 $(V_{EE} = -48V, V_{DD} = +3.3V, V_{AUTO} = V_{AGND} = V_{DGND} = 0V, \overline{RESET} = \overline{SHD}_{-} = unconnected, R_{SENSE} = 0.5\Omega$ , IVEE = 00, ICUT = 000, T<sub>A</sub> = +25°C, all registers = default setting, unless otherwise noted.)



#### ZERO-CURRENT DETECTION WAVEFORM









#### OVERCURRENT RESTART DELAY







## **Typical Operating Characteristics (continued)**

 $(V_{EE} = -48V, V_{DD} = +3.3V, V_{AUTO} = V_{AGND} = V_{DGND} = 0V, \overline{RESET} = \overline{SHD}_{-} = unconnected, R_{SENSE} = 0.5\Omega, IVEE = 00, ICUT = 000, T_A = +25^{\circ}C, all registers = default setting, unless otherwise noted.)$ 

# OA 100ms/div







100ms/div



DETECTION WITH INVALID PD (OPEN CIRCUIT, USING TYPICAL OPERATING CIRCUIT 1)



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## \_Typical Operating Characteristics (continued)

 $(V_{EE} = -48V, V_{DD} = +3.3V, V_{AUTO} = V_{AGND} = V_{DGND} = 0V, \overline{RESET} = \overline{SHD}_{-} = unconnected, R_{SENSE} = 0.5\Omega$ , IVEE = 00, ICUT = 000, T<sub>A</sub> = +25°C, all registers = default setting, unless otherwise noted.)





## **Pin Description**

PIN	NAME	FUNCTION
1	RESET	Hardware Reset. Pull $\overrightarrow{\text{RESET}}$ low for at least 300µs to reset the device. All internal registers reset to their default value. The address (A0–A3), and AUTO and MIDSPAN input-logic levels latch on during low-to-high transition of $\overrightarrow{\text{RESET}}$ . $\overrightarrow{\text{RESET}}$ is internally pulled up to V <sub>DD</sub> with a 50k $\Omega$ resistor.
2	MIDSPAN	Midspan Mode Input. An internal 50k $\Omega$ pulldown resistor to DGND sets the default mode to end-point PSE operation (power-over-signal pairs). Pull MIDSPAN to V <sub>DIG</sub> to set midspan operation. The MIDSPAN value latches after the IC is powered up or reset (see the <i>PD Detection</i> section).
3	ĪNT	Open-Drain Interrupt Output. INT goes low whenever a fault condition exists. Reset the fault condition using software or by pulling RESET low (see the <i>Interrupt</i> section for more information about interrupt management).
4	SCL	Serial Interface Clock Line Input
5	SDAOUT	Serial Output Data Line. Connect the data line optocoupler input to SDAOUT (see the <i>Typical Operating Circuits</i> ). Connect SDAOUT to SDAIN if using a 2-wire, I <sup>2</sup> C-compatible system.
6	SDAIN	Serial Interface Input Data Line. Connect the data line optocoupler output to SDAIN (see the <i>Typical Operating Circuits</i> ). Connect SDAIN to SDAOUT if using a 2-wire, I <sup>2</sup> C-compatible system.

## \_Pin Description (continued)

PIN	NAME	FUNCTION
7–10	A3–A0	Address Bits. A3–A0 form the lower part of the device's address. Address inputs default high with an internal 50k $\Omega$ pullup resistor to V <sub>DD</sub> . The address values latch when V <sub>DD</sub> or V <sub>EE</sub> ramps up and exceeds its UVLO threshold or after a reset. The 3 MSBs of the address are set to 010.
11–14	DET1-DET4	Detection/Classification Voltage Outputs. Use DET1 to set the detection and classification probe voltages on port 1. Use DET1 for the AC voltage sensing of port 1 when using the AC disconnect scheme (see the <i>Typical Operating Circuits</i> ).
15	DGND	Digital Ground. Connect to digital ground.
16	V <sub>DD</sub>	Positive Digital Supply. Connect to a digital power supply (reference to DGND).
17– 20	SHD1-SHD4	Port Shutdown Inputs. Pull $\overline{SHD}_{-}$ low to turn off the external FET on port Internally pulled up to V <sub>DD</sub> with a 50k $\Omega$ resistor.
21	AGND	Analog Ground. Connect to the high-side analog supply.
22, 25, 29, 32	SENSE4, SENSE3, SENSE2, SENSE1	MOSFET Source Current-Sense Negative Inputs. Connect to the source of the power MOSFET and connect a current-sense resistor between SENSE_ and V <sub>EE</sub> (see the <i>Typical Operating Circuits</i> ).
23, 26, 30, 33	GATE4, GATE3, GATE2, GATE1	Port_MOSFET Gate Drivers. Connect GATE_ to the gate of the external MOSFET (see the <i>Typical Operating Circuits</i> ).
24, 27, 31, 34	OUT4, OUT3, OUT2, OUT1	MOSFET Drain-Output Voltage Senses. Connect OUT_ to the power MOSFET drain through a resistor (100 $\Omega$ to 100k $\Omega$ ). The low leakage at OUT_ limits the drop across the resistor to less than 100mV (see the <i>Typical Operating Circuits</i> ).
28	V <sub>EE</sub>	Low-Side Analog Supply Input. Connect the low-side analog supply to V <sub>EE</sub> (-48V). Bypass with a 1 $\mu$ F capacitor between AGND and V <sub>EE</sub> .
35	AUTO	Auto or Shutdown Mode Input. Force AUTO high to enter auto mode after a reset or power-up. Drive low to put the MAX5952 into shutdown mode. In shutdown mode, software controls the operational modes of the MAX5952. A 50k $\Omega$ internal pulldown resistor defaults to AUTO low. AUTO latches when V <sub>DD</sub> or V <sub>EE</sub> ramps up and exceeds its UVLO threshold or when the device resets. Software commands can take the MAX5952 out of AUTO while AUTO is high.
36	OSC	Oscillator Input. AC-disconnect detection function uses OSC. Connect a 100Hz $\pm$ 10%, 2V <sub>P-P</sub> $\pm$ 5%, $\pm$ 1.2V offset sine wave to OSC. If the oscillator positive peak falls below the OSC_FAIL threshold of 2V, the ports that have the AC function enabled shut down and are not allowed to power-up. When not using the AC-disconnect detection function, leave OSC unconnected.



**Functional Diagram** 

**MAX5952** 

## **Detailed Description**

The MAX5952 is a quad -48V power controller designed for use in IEEE 802.3af-compliant/pre-IEEE 802.3at-compatible PSE. This device provides PD discovery, classification, current limit, DC and AC load disconnect detections in compliance with the IEEE 802.3af standard. The MAX5952 is pin compatible with the MAX5945/LTC4258/LTC4259A PSE controllers and provides additional features.

The MAX5952 features a high-power mode which provides up to 45W per port. The device allows the user to program the current-limit and overcurrent thresholds up to 2.5 times the default thresholds. The MAX5952 can also be programmed to decrease the current-limit and overcurrent threshold by 15% for high operating voltage conditions to keep the output power constant.

The MAX5952 provides instantaneous readout of each port current through the I<sup>2</sup>C interface. The MAX5952 also provides high-capacitance detection for legacy PDs.

The MAX5952 is fully software configurable and programmable through an I<sup>2</sup>C-compatible, 3-wire serial interface with 49 registers. The class-overcurrent detection function enables system power management to detect if a PD draws more than the allowable current. The MAX5952's extensive programmability enhances system flexibility, enables field diagnosis, and allows for uses in other applications.

The MAX5952 provides four operating modes to suit different system requirements. Auto mode allows the device to operate automatically without any software supervision. Semi-auto mode automatically detects and classifies a device connected to a port after initial software activation but does not power up that port until instructed to by software. Manual mode allows total software control of the device and is useful for system diagnostics. Shutdown mode terminates all activities and securely turns off power to the ports.

The MAX5952 provides input undervoltage lockout, input undervoltage detection, input overvoltage lockout, overtemperature detection, output voltage slew-rate limit during startup, power-good, and fault status. The MAX5952's programmability includes startup timeout, overcurrent timeout, and load-disconnect detection timeout. The MAX5952 communicates with the system microcontroller through an I<sup>2</sup>C-compatible interface. The MAX5952 features separate input and output data lines (SDAIN and SDAOUT) for use with optocoupler isolation. As a slave device, the MAX5952 includes four address inputs allowing 16 unique addresses. A separate INT output and four independent shutdown inputs (SHD\_) provide fast response from a fault to port shutdown between the MAX5952 and the microcontroller. A RESET input allows hardware reset of the device.

#### Reset

**MAX5952** 

Reset is a condition the MAX5952 enters after any of the following conditions:

- 1) After power-up (VEE and VDD rise above their UVLO thresholds).
- 2) Hardware reset. The RESET input is driven low and back high again any time after power-up.
- 3) Software reset. Writing a 1 into R1Ah[4] any time after power-up.
- 4) Thermal shutdown.

During a reset, the MAX5952 resets its register map to the reset state as shown in Table 37 and latches in the state of AUTO (pin 35) and MIDSPAN (pin 2). During normal operation, change at the AUTO and MIDSPAN input is ignored. While the condition that caused the reset persists (i.e. high temperature, RESET input low, or UVLO conditions) the MAX5952 does not acknowledge any addressing from the serial interface.

#### Port Reset (R1Ah[3:0])

Set high anytime during normal operation to turn off power and clear the events and status registers of the corresponding port. Port reset only resets the events and status registers.

#### **Midspan Mode**

In midspan mode, the device adopts cadence timing during the detection phase. When cadence timing is enabled and a failed detection occurs, the port waits between 2s and 2.4s before attempting to detect again. Midspan mode is activated by setting R11[1] high. The status of the MIDSPAN pin is written to R11[1] during power-up or after a reset. MIDSPAN is internally pulled low by a 50k $\Omega$  resistor.

### **Operation Modes**

The MAX5952 contains four independent, but identical state machines to provide reliable and real-time control of the four network ports. Each state machine has four operating modes: auto mode, semi-auto mode, manual, and shutdown. Auto mode allows the device to operate automatically without any software supervision. Semi-auto mode, upon request, continuously detects and classifies a device connected to a port but does not power up that port until instructed by software. Manual mode allows total software control of the device and is useful in system diagnostics. Shutdown mode terminates all activities and securely turns off power to the ports.

Switching between auto, semi, or manual mode does not interfere with the operation of the port. When the port is set into shutdown mode, all the port operations are immediately stopped and the port remains idle until shutdown is exited.

#### Automatic (Auto) Mode

Enter automatic (auto) mode by forcing the AUTO input high prior to a reset, or by setting R12h[P\_M1,P\_M0] to [1,1] during normal operation (see Tables 16 and 16a). In auto mode, the MAX5952 performs detection, classification, and powers up the port automatically once a valid PD is detected at the port. If a valid PD is not connected at the port, the MAX5952 repeats the detection routine continuously until a valid PD is connected.

Going into auto mode, the DET\_EN and CLASS\_EN bits are set to high and stay high unless changed by software. Using software to set DET\_EN and/or CLASS\_EN low causes the MAX5952 to skip detection and/or classification. As a protection, disabling the detection routine in auto mode does not allow the corresponding port to power up, unless the DET\_BY (R23H[4]) is set to 1.

The AUTO status is latched into the register only during a reset. Any changes to the AUTO input after reset are ignored.

#### Semi-Automatic (Semi-Auto) Mode

Enter semi-auto mode by setting R12h[P\_M1,P\_M0] to [1,0] during normal operation (see Tables 16 and 16a). In semi-auto mode, the MAX5952, upon request, performs detection and/or classification repeatedly but does not power up the port(s), regardless of the status of the port connection.

Setting R19h[PWR\_ON\_] (Table 22) high immediately terminates detection/classification routines and turns on power to the port(s).

R14h[DET\_EN\_, CLASS\_EN\_] default to low in semi-auto mode. Use software to set R14h[DET\_EN\_, CLASS\_EN\_] to high to start the detection and/or classification routines. R14h[DET\_EN\_, CLASS\_EN\_] are reset every time the software commands a power off of the port (either through reset or PWR\_OFF). In any other case, the status of the bits is left unchanged (including when the state machine turns off the power because a load disconnect or a fault condition is encountered).

#### Manual Mode

Enter manual mode by setting R12h[P\_M1,P\_M0] to [0,1] during normal operation (see Tables 16 and 16a). Manual mode allows the software to dictate any sequence of operation. Write a 1 to both R14h[DET\_EN\_] and R14h[CLASS\_EN\_] to start detection and classification operations, respectively, and in that priority order. After execution, the command is cleared from the register(s). PWR\_ON\_ has highest priority. Setting PWR\_ON\_ high at any time causes the device to immediately enter the powered mode. Setting DET\_EN and CLASS\_EN high at the same time causes detection to be performed first. Once in the powered state, the device ignores DET\_EN\_ or CLASS\_EN\_ commands.

When switching to manual mode from another mode, DET\_EN\_, CLASS\_EN\_ default to low. These bits become pushbutton rather than configuration bits (i.e., writing ones to these bits while in manual mode commands the device to execute one cycle of detection and/or classification. The bits are reset back to zeros at the end of the execution).

#### Shutdown Mode

Enter shutdown mode by forcing the AUTO input low prior to a reset, or by setting R12h[P\_M1,P\_M0] to [0,0] during normal operation (see Tables 16 and 16a). Putting the MAX5952 into shutdown mode immediately turns off power and halts all operations to the corresponding port. The event and status bits of the affected port(s) are also cleared. In shutdown mode, the DET\_EN\_, CLASS\_EN\_ and PWR\_ON\_ commands are ignored.

In shutdown mode, the serial interface operates normally.

#### **PD Detection**

When PD detection is activated, the MAX5952 probes the output for a valid PD. After each detection cycle, the device sets the DET\_END\_ bit R04h/05h[3:0] high and reports the detection results in the status registers R0Ch[2:0], R0Dh[2:0], R0Eh[2:0], and R0Fh[2:0]. The DET\_END\_ bit is reset to low when read through R05h or after a port reset.

A valid PD has a  $25k\Omega$  discovery signature characteristic as specified in the IEEE 802.3af/at standard. Table 1 shows the IEEE 802.3af/at specification for a PSE detecting a valid PD signature. See the *Typical Operating Circuits* and Figure 1 (Detection, Classification, and Power-Up Port Sequence). The MAX5952 can probe and categorize different types of devices connected to the port such as: a valid PD, an open circuit, a low resistive load, a high resistive load, a high capacitive load, a positive DC supply, or a negative DC supply.

During detection, the MAX5952 keeps the external MOSFET off and forces two probe voltages through the DET\_ input. The current through the DET\_ input is measured as well as the voltage at OUT\_. A two-point slope measurement is used as specified by the IEEE 802.3af standard to verify the device connected to the port. The MAX5952 implements appropriate settling times and a 100ms digital integration to reject 50Hz/60Hz power-line noise coupling.

An external diode, in series with the DET\_ input, restricts PD detection to the first quadrant as specified by the IEEE 802.3af/at standard. To prevent damage to non-PD devices, and to protect itself from an output short circuit, the MAX5952 limits the current into DET\_ to less than 2mA maximum during PD detection.

In midspan mode, the MAX5952 waits 2.2s before attempting another detection cycle after every failed detection. The first detection, however, happens immediately after issuing the detection command.

#### High-Capacitance Detection

The CLC\_EN bit in register R23h[5] enables the large capacitor detection feature for legacy PD devices. When CLC\_EN = 1, the high-capacitance detection limit is extended up to  $100\mu$ F. CLC\_EN = 0 is the default condition for the normal capacitor size detection. See Table 1 and the *Register Map and Description* section.

PARAMETER	SYMBOL	MIN	МАХ	UNITS	ADDITIONAL INFORMATION
Open-Circuit Voltage	V <sub>OC</sub>		30	V	In detection mode only
Short-Circuit Current	Isc		5	mA	In detection mode only
Valid Test Voltage	Vvalid	2.8	10	V	
Voltage Difference Between Test Points	ΔVTEST	1	—	V	
Time Between Any Two Test Points	t <sub>BP</sub>	2	_	ms	This timing implies a 500Hz maximum probing frequency
Slew Rate	V <sub>SLEW</sub>		0.1	V/µs	
Accept Signature Resistance	RGOOD	19	26.5	kΩ	
Reject Signature Resistance	R <sub>BAD</sub>	< 15	> 33	kΩ	
Open-Circuit Resistance	ROPEN	500	_	kΩ	
Accept Signature Capacitance	Cgood		150	nF	
Reject Signature Capacitance	CBAD	10	_	μF	
Signature Offset Voltage Tolerance	V <sub>OS</sub>	0	2.0	V	
Signature Offset Current Tolerance	IOS	0	12	μA	

## Table 1. PSE PI Detection Modes Electrical Requirement (Table 33-2 of the IEEE 802.3af Standard)

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#### Powered Device Classification (PD Classification)

During the PD classification mode, the MAX5952 forces a probe voltage (-18V) at DET\_ and measures the current into DET\_. The measured current determines the class of the PD.

After each classification cycle, the device sets the CL\_END\_ bit (R04h/05h[7:4]) high and reports the classification results in the status registers R0Ch[6:4], R0Dh[6:4], R0Eh[6:4], and R0Fh[6:4]. The CL\_END\_ bit is reset to low when read through register R05h or after a port reset. Both status registers, R04h, and R05h are cleared after the port powers down. Table 2 shows the IEEE 802.3af requirement for a PSE classifying a PD at the power interface (PI).

The MAX5952 supports high power beyond the IEEE 802.3af standard by providing additional classifications (Class 5 and ping-pong classification).

#### **Powered State**

When the MAX5952 enters a powered state, the t<sub>START</sub> and t<sub>DISC</sub> timers are reset. Before turning on the port power, the MAX5952 checks if any other port is not turning on and if the t<sub>FAULT</sub> timer is zero. Another check is performed if the ACD\_EN bit is set, in this case the OSC\_FAIL bit must be low (oscillator is okay) for the port to be powered.

## Table 2. PSE Classification of a PD (Table33-4 of the IEEE 802.3af)

MEASURED I <sub>CLASS</sub> (mA)	CLASSIFICATION
0 to 5	Class 0
> 5 and < 8	May be Class 0 and 1
8 to 13	Class 1
> 13 and < 16	May be Class 1 or 2
16 to 21	Class 2
> 21 and < 25	May be Class 2 or 3
25 to 31	Class 3
> 31 and < 35	May be Class 3 or 4
35 to 45	Class 4
> 45 and < 51	May be Class 4 or 5
51 to 68	Class 5

If these conditions are met, the MAX5952 enters startup where it turns on power to the port. An internal signal, POK\_, asserts high when V<sub>OUT</sub> is within 2V from V<sub>EE</sub>. PGOOD\_ status bits are set high if POK\_ stays high longer than t<sub>PGOOD</sub>. PGOOD immediately resets when POK goes low.

The PG\_CHG\_ bit sets when a port powers up or down. PWR\_EN sets when a port powers up and resets when a port shuts down. The port shutdown timer lasts 0.5ms and prevents other ports from turning off during that period, except in the case of emergency shutdowns (RESET = L, RESET\_IC = H, VEEUVLO, VDDUVLO, and TSHD).

The MAX5952 always checks the status of all ports before turning off. A priority logic system determines the order to prevent the simultaneous turn-on or turn-off of the ports. The port with the lesser ordinal number gets priority over the others (i.e., port 1 turns on first, port 2 second, port 3 third and port 4 fourth). Setting PWR\_OFF\_ high turns off power to the corresponding port.



Figure 1. Detection, Classification, and Power-Up Port Sequence



Figure 2. PGOOD Timing

#### **Overcurrent Protection**

A sense resistor Rs connected between SENSE\_ and VFF monitors the load current. Under normal operating conditions, the voltage across Rs (VRs) never exceeds the threshold VSU LIM. If VRS exceeds VSU LIM, an internal current-limiting circuit regulates the GATE voltage, limiting the current to ILIM = VSU LIM / Rs. During transient conditions, if  $V_{RS}$  exceeds  $\overline{V}_{SU}$  LIM by more than 1V, a fast pulldown circuit activates to quickly recover from the current overshoot. During startup, if the current-limit condition persists, when the startup timer, tSTART, times out, the port shuts off, and the STRT\_FLT\_ bit is set. In the normal powered state, the MAX5952 checks for overcurrent conditions as determined by VFLT LIM = ~88% of VSU LIM. The tFAULT counter sets the maximum allowed continuous overcurrent period. The tFAULT counter increases when VRS exceeds V<sub>FLT LIM</sub> and decreases at a slower pace when V<sub>RS</sub> drops below V<sub>FLT LIM</sub>. A slower decrement for the tFAULT counter allows for detecting repeated short-duration overcurrents. When the counter reaches the tFAULT limit, the MAX5952 powers off the port and asserts the IMAX\_FLT\_ bit. For a continuous overstress, a fault latches exactly after a period of tFAULT. VSU LIM

is programmable through the ICUT registers R2Ah[6:4], R2Ah[2:0], R2Bh[6:4], R2Bh[2:0], and the IVEE bits in register R29h[1:0]. See the *High-Power Mode* section for more information on the ICUT register.

After power-off due to an overcurrent fault, and if the RSTR\_EN bit is set, the  $t_{FAULT}$  timer is not immediately reset but starts decrementing at the same slower pace. The MAX5952 allows the port to be powered on only when the  $t_{FAULT}$  counter is at zero. This feature sets an automatic duty-cycle protection to the external MOS-FET avoiding overheating.

The MAX5952 continuously flags when the current exceeds the maximum current allowed for the class as indicated in the CLASS status register. When class overcurrent occurs, the MAX5952 sets the IVC bit in register R09h.

#### **ICUT Register and High-Power Mode**

#### **ICUT Register**

The ICUT register determines the maximum current limits allowed for each port of the MAX5952. The 3 ICUT bits (R2Ah[6:4], R2Ah[2:0], R2Bh[6:4], and R2Bh[2:0]) allow programming of the current-limit and overcurrent thresholds in excess of the IEEE standard limit (see Tables 34a, 34b, and 34c). The ICUT registers can be written to directly through the I<sup>2</sup>C interface when CL\_DISC (R17h[2]) is set to 0 (see Table 3). In this case, the current limit of the port is configured regardless of the status of the classification.

By setting the CL\_DISC bit to 1, the MAX5952 automatically sets the ICUT register based upon the classification result of the port. See Table 3 and the *Register Map and Description* section.

CL_DISC	PORT CLASSIFICATION RESULT	RESULTING ICUT REGISTER BITS
0	Any	User programmed
1	1	ICUT = 110
1	2	ICUT = 111
1	0, 3	ICUT = 000

## **Table 3. Automatic ICUT Programming**

### High-Power Mode

When CL\_DISC (R17h[2]) is set to 0, high-power mode is configured by setting the ICUT bits to any combination other than 000, 110, or 111 (note that 000 is the default value for the IEEE standard limit). See Table 3 and the *Register Map and Description* section.

#### **Foldback Current**

During startup and normal operation, an internal circuit senses the voltage at OUT\_ and reduces the current-limit value when (V<sub>OUT</sub> - V<sub>EE</sub>) > 28V. The foldback function helps to reduce the power dissipation on the FET. The current limit eventually reduces to 1/3 of I<sub>LIM</sub> when (V<sub>OUT</sub> - V<sub>EE</sub>) > 48V (see Figure 3a). For high-power mode, the foldback starts when (V<sub>OUT</sub> - V<sub>EE</sub>) > 10V (see Figure 3b). In high-power mode, the current limit (I<sub>LIM</sub>) is reduced up to 1/8 of its programmed value when (V<sub>OUT</sub> - V<sub>EE</sub>) > 48V.

#### **MOSFET Gate Driver**

Connect the gate of the external n-channel MOSFET to GATE\_. An internal  $50\mu$ A current source pulls GATE\_ to (VEE + 10V) to turn on the MOSFET. An internal  $40\mu$ A

current source pulls down GATE\_ to  $\mathsf{V}_{\mathsf{EE}}$  to turn off the MOSFET.

The pullup and pulldown current controls the maximum slew rate at the output during turn-on or turn-off. Use the following equation to set the maximum slew rate:

$$\frac{\Delta V_{OUT}}{\Delta t} = \frac{I_{GATE}}{C_{GD}}$$

where C<sub>GD</sub> is the total capacitance between GATE and DRAIN of the external MOSFET. Current limit and the capacitive load at the drain control the slew rate during startup. During current-limit regulation, the MAX5952 manipulates the GATE\_ voltage to control the voltage at SENSE\_ (V<sub>RS</sub>). A fast pulldown activates if V<sub>RS</sub> overshoots the limit threshold (V<sub>SU\_LIM</sub>). The fast pulldown current increases with the amount of overshoot. The maximum fast pulldown current is 100mA.

During turn-off, when the GATE voltage reaches a value lower than 1.2V, a strong pulldown switch is activated to keep the MOSFET securely off.



Figure 3a. Foldback Current Characteristics



Figure 3b. Foldback Current Characteristics for High-Power Mode

### **Digital Logic**

VDD supplies power for the internal logic circuitry. VDD ranges from +3.0V to +5.5V and determines the logic thresholds for the CMOS connections (SDAIN, SDAOUT, SCL, AUTO, SHD\_, A\_). This voltage range enables the MAX5952 to interface with a nonisolated low-voltage microcontroller. The MAX5952 checks the digital supply for compatibility with the internal logic. The MAX5952 also features a VDD undervoltage lockout (VDDUVLO) of +2.0V. A VDDUVLO condition keeps the MAX5952 in reset and the ports shut off. Bit 0 in the supply event register shows the status of VDDUVLO (Table 12) after VDD has recovered. All logic inputs and outputs reference to DGND. DGND and AGND must be connected together externally. Connect DGND to AGND at a single point in the system as close as possible to the MAX5952.

#### Hardware Shutdown

SHD\_ shuts down the respective ports without using the serial interface. Hardware shutdown offers an emergency turn-off feature that allows a fast disconnect of the power supply from the port. Pull SHD\_ low to remove power. SHD\_ also resets the corresponding events and status register bits.

#### Interrupt

The MAX5952 contains an open-drain logic output (INT) that goes low when an interrupt condition exists. R00h and R01h (Tables 6 and 7) contain the definitions of the interrupt registers. The mask register R01h determines events that trigger an interrupt. As a response to an interrupt, the controller reads the status of the event register to determine the cause of the interrupt and takes subsequent actions. Each interrupt event register also contains a Clear on Read (CoR) register. Reading through the CoR register address clears the interrupt. INT remains low when reading the interrupt through the read-only addresses. For example, to clear a startup fault on the port 4 read address 09h (see Table 11). Use the global pushbutton bit in register 1Ah (bit 7, Table 23) to clear interrupts, or use a software or hardware reset.

#### Undervoltage and Overvoltage Protection

The MAX5952 contains several undervoltage and overvoltage protection features. Table 12 in the *Register Map and Description* section shows a detailed list of the undervoltage and overvoltage protection features. An internal VEE undervoltage lockout (VEEUVLO) circuit keeps the MOSFET off and the MAX5952 in reset until VAGND - VEE exceeds 29V for more than 3ms. An internal VEE overvoltage (VEE\_OV) circuit shuts down the ports when (VAGND - VEE) exceeds 60V. The digital



supply also contains an undervoltage lockout (VDDUVLO). The MAX5952 also features three other undervoltage and overvoltage interrupts: VEE undervoltage interrupt (VEEUV), VDD undervoltage interrupt (VDDUV), and VDD overvoltage interrupt (VDDOV). A fault latches into the supply events register (Table 12), but the MAX5952 does not shut down the ports with VEEUV, VDDUV, or VDDOV.

### **DC** Disconnect Monitoring

Setting R13h[DCD\_EN\_] bits high enable DC load monitoring during a normal powered state. If  $V_{RS}$  (the voltage across R<sub>S</sub>) falls below the DC load disconnect threshold,  $V_{DCTH}$ , for more than t<sub>DISC</sub>, the device turns off power and asserts the LD\_DISC\_ bit of the corresponding port.

#### **AC Disconnect Monitoring**

The MAX5952 features AC load disconnect monitoring. Connect an external sine wave to OSC. The oscillator requirements are:

- 1) VP-P x Frequency =  $200VP-P \times Hz \pm 15\%$
- 2) Positive peak voltage > +2V
- 3) Frequency > 60Hz
- A 100Hz  $\pm$ 10%, 2V<sub>P-P</sub>  $\pm$ 5%, with  $\pm$ 1.2V offset (V<sub>PEAK</sub> =  $\pm$ 2.2V typical) is recommended.

The MAX5952 buffers and amplifies 3x the external oscillator signal and sends the signal to DET\_, where the sine wave is AC-coupled to the output. The MAX5952 senses the presence of the load by monitoring the amplitude of the AC current returned to DET\_ (see the *Functional Diagram*).

Setting R13h[ACD\_EN\_] bits high enable AC load disconnect monitoring during a normal powered state. If the AC current peak at the DET\_ input falls below I<sub>ACTH</sub> for more than t<sub>DISC</sub>, the device turns off power and asserts the LD\_DISC\_ bit of the corresponding port. I<sub>ACTH</sub> is programmable using R23h[0-3].

An internal comparator checks for a proper amplitude of the oscillator input. If the positive peak of the input sinusoid falls below a safety value of 2V, OSC\_FAIL sets and the port shuts down. Power cannot be applied to the ports when ACD\_EN is set high and OSC\_FAIL is set high. Leave OSC unconnected or connect it to DGND when not using AC-disconnect detection.

#### **Thermal Shutdown**

If the MAX5952 die temperature reaches +150°C, an overtemperature fault generates and the MAX5952 shuts down. The MOSFETs turn off. The die temperature of the MAX5952 must cool down below 130°C to remove the overtemperature fault condition. After a thermal shutdown, the part is reset.

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## Watchdog

R1Dh, R1Eh, and R1Fh registers control the watchdog operation. The watchdog function, when enabled, allows the MAX5952 to gracefully take over control or securely shuts down the power to the ports in case of software/ firmware crashes. Contact the factory for more details.

#### **Address Inputs**

A3, A2, A1, and A0 represent the four LSBs of the chip address. The complete chip address is 7 bits (see Table 4).

## Table 4. MAX5952 Address

0 1 0	A3	A2	A1	A0	R/W
-------	----	----	----	----	-----

The four LSBs latch on the low-to-high transition of  $\overline{\text{RESET}}$  or after a power-supply start (either on V\_DD or V\_EE). Address inputs default high through an internal 50k $\Omega$  pullup resistor to V\_DD. The MAX5952 also responds to the call through a global address 30h (see the *Global Addressing and Alert Response Protocol* section).

## I<sup>2</sup>C-Compatible Serial Interface

The MAX5952 operates as a slave that sends and receives data through an I<sup>2</sup>C-compatible, 2-wire or 3-wire interface. The interface uses a serial-data input line (SDAIN), a serial-data output line (SDAOUT), and a serial-clock line (SCL) to achieve bidirectional communication between master(s) and slave(s). A master (typically a microcontroller) initiates all data transfers to and from the MAX5952, and generates the SCL clock that synchronizes the data transfer. In most applications, connect the SDAIN and the SDAOUT lines together to form the serial-data line (SDA).

Using the separate input and output data lines allows optocoupling with the controller bus when an isolated supply powers the microcontroller.

The MAX5952 SDAIN line operates as an input. The MAX5952 SDAOUT operates as an open-drain output. A pullup resistor, typically 4.7k $\Omega$ , is required on SDAOUT. The MAX5952 SCL line operates only as an input. A pullup resistor, typically 4.7k $\Omega$ , is required on SCL if there are multiple masters, or if the master in a single-master system has an open-drain SCL output.



Figure 4. 2-Wire Serial Interface Timing Details



Figure 5. 3-Wire Serial Interface Timing Details



#### Serial Addressing

Each transmission consists of a START condition (Figure 6) sent by a master, followed by the MAX5952 7-bit slave address plus R/W bit, a register address byte, one or more data bytes, and finally a STOP condition.

#### START and STOP Conditions

Both SCL and SDA remain high when the interface is not busy. A master signals the beginning of a transmission with a START (S) condition by transitioning SDA from high to low while SCL is high. When the master finishes communicating with the slave, the master issues a STOP (P) condition by transitioning SDA from low to high while SCL is high. The STOP condition frees the bus for another transmission.

### Bit Transfer

Each clock pulse transfers one data bit (Figure 7). The data on SDA must remain stable while SCL is high.

### Acknowledge

The acknowledge bit is a clocked 9th bit (Figure 8) that the recipient uses to handshake receipt of each byte of data. Thus each byte effectively transferred requires 9 bits. The master generates the 9th clock pulse, and the recipient pulls down SDA (or the SDAOUT in the 3-wire interface) during the acknowledge clock pulse, so that the SDA line is stable low during the high period of the clock pulse. When the master transmits to the MAX5952, the MAX5952 generates the acknowledge bit. When the MAX5952 transmits to the master, the master generates the acknowledge bit.



Figure 6. START and STOP Conditions

Figure 7. Bit Transfer



Figure 8. Acknowledge

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#### Slave Address

The MAX5952 has a 7-bit long slave address (Figure 9). The bit following the 7-bit slave address (bit eight) is the R/W bit, which is low for a write command and high for a read command.

010 always represents the first three bits (MSBs) of the MAX5952 slave address. Slave address bits A3, A2, A1, and A0 represent the states of the MAX5952's A3, A2, A1, and A0 inputs, allowing up to sixteen MAX5952 devices to share the bus. The states of the A3, A2, A1 and A0 latch in upon the reset of the MAX5952 into register R11h. The MAX5952 monitors the bus continuously, waiting for a START condition followed by the MAX5952's slave address. When a MAX5952 recognizes its slave address, the MAX5952 acknowledges and is then ready for continued communication.

**Global Addressing and Alert Response Protocol** The global address call is used in writing mode to write the same register to multiple devices (address 0x60). In read mode (address 0x61), the global address call is used as the alert response address. When responding to a global call, the MAX5952 puts out on the data line its own address whenever its interrupt is active. So does every other device connected to the SDAOUT line that has an active interrupt. After every bit transmitted, the MAX5952 checks that the data line effectively corresponds to the data it is delivering. If it is not, it then backs off and frees the data line. This litigation protocol always allows the part with the lowest address to complete the transmission. The microcontroller can then respond to the interrupt and take proper actions. The MAX5952 does not reset its own interrupt at the end of the alert response protocol. The microcontroller has to do it by clearing the event register through their CoR adresses or activating the CLR\_INT pushbutton.

#### Message Format for Writing to the MAX5952 A write to the MAX5952 comprises of the MAX5952's slave address transmission with the R/W bit set to 0, followed by at least one byte of information. The first byte of information is the command byte (Figure 10). The command byte determines which register of the MAX5952 is written to by the next byte, if received. If the MAX5952 detects a STOP condition after receiving the command byte, the MAX5952 takes no further action beyond storing the command byte. Any bytes received after the command byte are data bytes. The first data byte goes into the internal register of the MAX5952 selected by the command byte. If the MAX5952 transmits multiple data bytes before the MAX5952 detects a STOP condition, these bytes store in subsequent MAX5952 internal registers because the control byte address auto-increments.



Figure 9. Slave Address



Figure 10. Control Byte Received

#### Message Format for Reading

The MAX5952 reads using the MAX5952's internally stored command byte as an address pointer, the same way the stored command byte is used as an address pointer for a write. The pointer auto-increments after reading each data byte using the same rules as for a write. Thus, a read is initiated by first configuring the MAX5952's command byte by performing a write (Figure 11). The master now reads 'n' consecutive bytes from the MAX5952, with the first data byte read from the register addressed by the initialized command byte (Figure 12). When performing read-after-write verification, remember to reset the command byte's address because the stored control byte address auto-increments after the write.

#### **Operation with Multiple Masters**

When the MAX5952 operates on a 2-wire interface with multiple masters, a master reading the MAX5952 should use repeated starts between the write which sets the MAX5952's address pointer, and the read(s) that take the data from the location(s). It is possible for master 2 to take over the bus after master 1 has set up

the MAX5952's address pointer but before master 1 has read the data. If master 2 subsequently resets the MAX5952's address pointer then master 1's read may be from an unexpected location.

### Command Address Auto-Incrementing

Address auto-incrementing allows the MAX5952 to be configured with fewer transmissions by minimizing the number of times the command address needs to be sent. The command address stored in the MAX5952 generally increments after each data byte is written or read (Table 5). The MAX5952 is designed to prevent overwrites on unavailable register addresses and unintentional wrap-around of addresses.

## Table 5. Auto-Increment Rules

COMMAND BYTE ADDRESS RANGE	AUTO-INCREMENT BEHAVIOR
0x00 to 0x26	Command address auto-increments after byte read or written
0x26	Command address remains at 0x26 after byte written or read



Figure 11. Control and Single Data Byte Received



Figure 12. 'n' Data Bytes Received

## \_Register Map and Description

The interrupt register (Table 6) summarizes the event register status and is used to send an interrupt signal (INT goes low) to the controller. Writing a 1 to R1Ah[7] clears all interrupt and events registers. A reset sets R00h to 00h.

INT\_EN (R17h[7]) is a global interrupt mask (Table 7). The MASK\_ bits activate the corresponding interrupt bits in register R00h. Writing a 0 to INT\_EN (R17h[7]) disables the INT output.

A reset sets R01h to AAA00A00b where A is the state of the AUTO input prior to the reset.

## Table 6. Interrupt Register

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ADDRESS = 00h			DESCRIPTION	
SYMBOL	BIT	R/W	DESCRIPTION	
SUP_FLT	7	R	Interrupt signal for supply faults. SUP_FLT is the logic OR of all the bits [7:0] in register R0Ah/R0Bh (Table 12).	
TSTR_FLT	6	R	Interrupt signal for startup failures. TSTR_FLT is the logic OR of bits [7:0] in register R08h/R09h (Table 11).	
IMAX_FLT	5	R	Interrupt signal for current-limit violations. IMAX_FLT is the logic OR of bits [3:0] in register R06h/R07h (Table 10).	
CL_END	4	R	Interrupt signal for completion of classification. CL_END is the logic OR of bits [7:4] in register R04h/R05h (Table 9).	
DET_END	3	R	Interrupt signal for completion of detection. DET_END is the logic OR of bits [3:0] in register R04h/R05h (Table 9).	
LD_DISC	2	R	Interrupt signal for load disconnection. LD_DISC is the logic OR of bits [7:4] in register R06h/R07h (Table 10).	
PG_INT	1	R	Interrupt signal for PGOOD status change. PG_INT is the logic OR of bits [7:4] in register R02h/R03h (Table 8).	
PE_INT	0	R	Interrupt signal for power-enable status change. PEN_INT is the logic OR of bits [3:0] in register R02h/R03h (Table 8).	

## Table 7. Interrupt Mask Register

ADDRESS = 01h			DESCRIPTION			
SYMBOL	BIT	R/W	DESCRIPTION			
MASK7	7	R/W	Interrupt mask bit 7. A logic-high enables the SUP_FLT interrupts. A logic-low disables the SUP_FLT interrupts.			
MASK6	6	R/W	Interrupt mask bit 6. A logic-high enables the TSTR_FLT interrupts. A logic-low disables the TSTR_FLT interrupts.			
MASK5	5	R/W	Interrupt mask bit 5. A logic-high enables the IMAX_FLT interrupts. A logic-low disables the IMAX_FLT interrupts.			
MASK4	4	R/W	Interrupt mask bit 4. A logic-high enables the CL_END interrupts. A logic-low disables the CL_END interrupts.			
MASK3	3	R/W	Interrupt mask bit 3. A logic-high enables the DET_END interrupts. A logic-low disables the DET_END interrupts.			
MASK2	2	R/W	Interrupt mask bit 2. A logic-high enables the LD_DISC interrupts. A logic-low disables the LD_DISC interrupts.			
MASK1	1	R/W	Interrupt mask bit 1. A logic-high enables the PG_INT interrupts. A logic-low disables the PG_INT interrupts.			
MASKO	0	R/W	Interrupt mask bit 0. A logic-high enables the PEN_INT interrupts. A logic-low disables the PEN_INT interrupts.			



The power event register (Table 8) records changes in the power status of the four ports. Any change in PGOOD\_ (R10h[7:4]) sets PG\_CHG\_ to 1. Any change in the PWR\_EN\_ (R10h[3:0]) sets PWEN\_CHG\_ to 1. PG\_CHG\_ and PWEN\_CHG\_ trigger on the edges of PGOOD\_ and PWR\_EN\_ and do not depend on the actual level of the bits. The power event register has two addresses. When read through the R02h address, the content of the register is left unchanged. When read through the CoR R03h address, the register content is cleared. A reset sets R02h/R03h = 00h.

ADDRESS =		02h	03h	DESCRIPTION
SYMBOL	BIT	R/W	R/W	DESCRIPTION
PG_CHG4	7	R	CoR	PGOOD change event for port 4
PG_CHG3	6	R	CoR	PGOOD change event for port 3
PG_CHG2	5	R	CoR	PGOOD change event for port 2
PG_CHG1	4	R	CoR	PGOOD change event for port 1
PWEN_CHG4	3	R	CoR	Power enable change event for port 4
PWEN_CHG3	2	R	CoR	Power enable change event for port 3
PWEN_CHG2	1	R	CoR	Power enable change event for port 2
PWEN_CHG1	0	R	CoR	Power enable change event for port 1

## Table 8. Power Event Register

DET\_END\_/CL\_END\_ is set high whenever detection/ classification is completed on the corresponding port. A 1 in any of the CL\_END\_ bits forces R00h[4] to 1. A 1 in any of the DET\_END\_ bits forces R00h[3] to 1. As with any of the other events register, the detect event register has two addresses. When read through the R04h address, the content of the register is left unchanged. When read through the CoR R05h address, the register content is cleared. A reset sets R04h/R05h = 00h.

## Table 9. Detect Event Register

ADDRESS =		04h	05h	DESCRIPTION
SYMBOL	BIT	R/W	R/W	DESCRIPTION
CL_END4	7	R	CoR	Classification completed on port 4
CL_END3	6	R	CoR	Classification completed on port 3
CL_END2	5	R	CoR	Classification completed on port 2
CL_END1	4	R	CoR	Classification completed on port 1
DET_END4	3	R	CoR	Detection completed on port 4
DET_END3	2	R	CoR	Detection completed on port 3
DET_END2	1	R	CoR	Detection completed on port 2
DET_END1	0	R	CoR	Detection completed on port 1

LD\_DISC\_ is set high whenever the corresponding port shuts down due to detection of load removal. IMAX\_FLT\_ is set high when the port shuts down due to an extended overcurrent event after a successful startup. A 1 in any of the LD\_DISC\_ bits forces R00h[2] to 1. A 1 in any of the IMAX\_FLT\_ bits forces R00h[5] to 1. As with any of the other events register, the fault event register has two addresses. When read through the R06h address, the content of the register is left unchanged. When read through the CoR R07h address, the register content is cleared. A reset sets R06h/R07h = 00h.

ADDRESS =		06h 07	07h	DESCRIPTION
SYMBOL	BIT	R/W	R/W	DESCRIPTION
LD_DISC4	7	R	CoR	Disconnect on port 4
LD_DISC3	6	R	CoR	Disconnect on port 3
LD_DISC2	5	R	CoR	Disconnect on port 2
LD_DISC1	4	R	CoR	Disconnect on port 1
IMAX_FLT4	3	R	CoR	Overcurrent on port 4
IMAX_FLT3	2	R	CoR	Overcurrent on port 3
IMAX_FLT2	1	R	CoR	Overcurrent on port 2
IMAX_FLT1	0	R	CoR	Overcurrent on port 1

## Table 10. Fault Event Register

If the port remains in current limit or the PGOOD condition is not met at the end of the startup period, the port shuts down and the corresponding STRT\_FLT\_ is set to 1. A 1 in any of the STRT\_FLT\_ bits forces R00h[6] to 1. IVC\_ is set to 1 whenever the port current exceeds the maximum allowed limit for the class (determined during the classification process). A 1 in any of IVC\_ forces R00h[6] to 1. When the CL\_DISC (R17h[2]) is set to 1, the port also limits the load current according to its class as specified in the *Electrical Characteristics* table. As with any of the other events register, the startup event register has two addresses. When read through the R08h address, the content of the register is left unchanged. When read through the CoR R09h address, the register content is cleared. A reset sets R08h/R09h = 00h.

## Table 11. Startup Event Register

ADDRESS =		08h	09h	DESCRIPTION
SYMBOL	BIT	R/W	R/W	DESCRIPTION
IVC4	7	R	CoR	Class overcurrent flag for port 4
IVC3	6	R	CoR	Class overcurrent flag for port 3
IVC2	5	R	CoR	Class overcurrent flag for port 2
IVC1	4	R	CoR	Class overcurrent flag for port 1
STRT_FLT4	3	R	CoR	Startup failed on port 4
STRT_FLT3	2	R	CoR	Startup failed on port 3
STRT_FLT2	1	R	CoR	Startup failed on port 2
STRT_FLT1	0	R	CoR	Startup failed on port 1

The MAX5952 continuously monitors the power supplies and sets the appropriate bits in the supply event register (Table 12).  $V_{DD_ov}/V_{EE_ov}$  is set to 1 whenever  $V_{DD}/V_{EE}$  exceeds its overvoltage threshold.  $V_{DD_ov}/V_{EE_ov}$  is set to 1 whenever  $V_{DD}/V_{EE}$  falls below its undervoltage threshold.

OSC\_FAIL is set to 1 whenever the amplitude of the oscillator signal at the OSC\_ input falls below a level that might compromise the AC disconnect detection function. OSC\_FAIL generates an interrupt only if at least one of the ACD\_EN (R13h[7:4]) bits is set high.

A thermal shutdown circuit monitors the temperature of the die and resets the MAX5952 if the temperature exceeds +150°C. TSD is set to 1 after the MAX5952 returns to normal operation. TSD is also set to 1 after every UVLO reset. When V<sub>DD</sub> and/or IV<sub>EE</sub>I is below its UVLO threshold, the MAX5952 is in reset mode and securely holds all ports off. When V<sub>DD</sub> and IV<sub>EE</sub>I rise to above their respective UVLO thresholds, the device comes out of reset as soon as the last supply crosses the UVLO threshold. The last supply corresponding UV and UVLO bits in the supply event register is set to 1.

A 1 in any supply event register's bits forces R00h[7] to 1. As with any of the other events register, the supply event register has two addresses. When read through the R0Ah address, the content of the register is left unchanged. When read through the CoR R0Bh address, the register content is cleared. A reset sets R0Ah/R0Bh to 10100001b if V<sub>DD</sub> comes up after V<sub>EE</sub> or to 10010100b if V<sub>EE</sub> comes up after V<sub>DD</sub>.

ADDRESS =		0Ah	0Bh	DESCRIPTION
SYMBOL	BIT	R/W	R/W	DESCRIPTION
TSD	7	R	CoR	Overtemperature shutdown
V <sub>DD_OV</sub>	6	R	CoR	V <sub>DD</sub> overvoltage condition
V <sub>DD_UV</sub>	5	R	CoR	V <sub>DD</sub> undervoltage condition
VEE_UVLO	4	R	CoR	VEE undervoltage lockout condition
VEE_OV	3	R	CoR	V <sub>EE</sub> overvoltage condition
V <sub>EE_UV</sub>	2	R	CoR	V <sub>EE</sub> undervoltage condition
OSC_FAIL	1	R	CoR	Oscillator amplitude is below limit
VDD_UVLO	0	R	CoR	V <sub>DD</sub> undervoltage lockout condition

## Table 12. Supply Event Register

The port status register (Table 13a) records the results of the detection and classification at the end of each phase in three encoding bits each. R0Ch contains the detection and classification status of port 1. R0Dh corresponds to port 2, R0Eh corresponds to port 3, and R0Fh corresponds to port 4. Tables 13b and 13c show the detection/classification result decoding charts, respectively. For CLC\_EN = 0, the detection result is shown in Table 13b. When CLC\_EN is set high, the MAX5952 allows valid detection of high capacitive load of up to 100µF.

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When ping-pong classification is not enabled (ENx\_CL6 = 0), the classification status is reported in Table 13c. When ping-pong classification is enabled (ENx\_CL6 = 1), the CLASS\_[2:0] bits are set to 000 and the classification result is reported in locations R2Ch-R2Fh.

As a protection, when POFF\_CL (R17h[3], Table 21) is set to 1, the MAX5952 prohibits turning on power to the port that returns a status 111 after classification. A reset sets 0Ch, 0Dh, 0Eh, and 0Fh = 00h.

## Table 13a. Port Status Registers

ADDRESS = 0Ch, 0Dh, 0Eh, 0Fh			DECODIDITION
SYMBOL	BIT	R/W	DESCRIPTION
Reserved	7	R	Reserved
	6	R	CLASS_[2]
CLASS_ 5 R	CLASS_[1]		
4 R (		R	CLASS_[0]
Reserved	3	R	Reserved
	2	R	DET_[2]
DET_ST_	1	R	DET_[1]
	0	R	DET_[0]

## Table 13b. Detection Result Decoding Chart

DET_ST_[2:0] (ADDRESS = 0Ch, 0Dh, 0Eh, 0Fh)	DETECTED	DESCRIPTION	
000	None	Detection status unknown	
001	DCP Positive DC supply connected at the port (AGND - V <sub>OUT_</sub> < 1		
010	HIGH CAP High capacitance at the port (> 8.5µF)		
011	RLOW	Low resistance at the port, $R_{PD} < 15 k\Omega$	
100	DET_OK Detection pass, $15k\Omega > R_{PD} > 33k\Omega$		
101	RHIGH	High resistance at the port, $R_{PD}$ > 33k $\Omega$	
110	OPEN0	Open port (I < 10µA)	
111	DCN	Negative DC supply connected to the port ( $V_{OUT} - V_{EE} < 2V$ )	

## Table 13c. Classification Result DecodingChart

CLASS_[2:0] (ADDRESS = 0Ch, 0Dh, 0Eh, 0Fh)	CLASS RESULT
000	Unknown
001	1
010	2
011	3
100	4
101	5
110	0
111	Current limit (> ICILIM)

PGOOD\_ is set to 1 (Table 14) at the end of the powerup startup period if the power-good condition is met (0 < (V<sub>OUT</sub> - V<sub>EE</sub>) < PG<sub>TH</sub>). The power-good condition must remain valid for more than t<sub>PGOOD</sub> to assert PGOOD\_. PGOOD\_ is reset to 0 whenever the output falls out of the power-good condition. A fault condition immediately forces PGOOD\_ low. PWR\_EN\_ is set to 1 when the port power is turned on. PWR\_EN resets to 0 as soon as the port turns off. Any transition of PGOOD\_ and PWR\_EN\_ bits set the corresponding bit in the power event registers R02h/R03h (Table 8). A reset sets R10h = 00h.

Table 14	I. Power	Status	Register
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ADDRESS = 10h			DESCRIPTION
SYMBOL	BIT	R/W	DESCRIPTION
PGOOD4	7	R	Power-good condition on port 4
PGOOD3	6	R	Power-good condition on port 3
PGOOD2	5	R	Power-good condition on port 2
PGOOD1	4	R	Power-good condition on port 1
PWR_EN4	3	R	Power is enabled on port 4
PWR_EN3	2	R	Power is enabled on port 3
PWR_EN2	1	R	Power is enabled on port 2
PWR_EN1	0	R	Power is enabled on port 1

A3, A2, A1, A0 (Table 15) represent the four LSBs of the MAX5952 address (Table 4). During a reset, the device latches into R11h. These four bits address from

the corresponding inputs as well as the state of the MIDSPAN and AUTO inputs. Changes to those inputs during normal operation are ignored.

Table	15.	Address	Input	Status	Register
I GOIO		Addi 000	mpac	oluluo	riogiotor

ADDRESS = 11h			DESCRIPTION	
SYMBOL	BIT	R/W	DESCRIPTION	
Reserved	7	R	Reserved	
Reserved	6	R	Reserved	
A3	5	R	Device address, A3 pin latched-in status	
A2	4	R	Device address, A2 pin latched-in status	
A1	3	R	Device address, A1 pin latched-in status	
AO	2	R	Device address, A0 pin latched-in status	
MIDSPAN	1	R	MIDSPAN input's latched-in status	
AUTO	0	R	AUTO input's latched-in status	

The MAX5952 uses two bits for each port to set the mode of operation. Set the modes according to Table 16a.

A reset sets R12h = AAAAAAAA where A represents the latched-in state of the AUTO input prior to the reset.

Use software to change the mode of operation. Software resets of ports (RESET\_P\_ bit, Table 23) do not affect the mode register.

## Table 16. Mode Register

ADDRESS = 12h			DECODIDITION	
SYMBOL	BIT	R/W	DESCRIPTION	
P4_M1	7	R/W	MODE[1] for port 4	
P4_M0	6	R/W	MODE[0] for port 4	
P3_M1	5	R/W	MODE[1] for port 3	
P3_M0	4	R/W	MODE[0] for port 3	
P2_M1	3	R/W	MODE[1] for port 2	
P2_M0	2	R/W	MODE[0] for port 2	
P1_M1	1	R/W	MODE[1] for port 1	
P1_M0	0	R/W	MODE[0] for port 1	

## Table 16a. Mode Status

MODE	DESCRIPTION
00	Shutdown
01	Manual
10	Semi-auto
11	Auto

Setting DCD\_EN\_ to 1 enables the DC load disconnect detection feature (Table 17). Setting ACD\_EN\_ to 1 enables the AC load disconnect feature. If enabled, the load disconnect detection starts during power mode

and after startup when the corresponding PGOOD\_ bit in register R10h (Table 14) goes high. A reset sets R13h = 0000AAAA where A represents the latched-in state of the AUTO input prior to the reset.

 Table 17. Load Disconnect Detection Enable Register

ADDRESS = 13h			DESCRIPTION
SYMBOL	BIT	R/W	DESCRIPTION
ACD_EN4	7	R/W	Enable AC disconnect detection on port 4
ACD_EN3	6	R/W	Enable AC disconnect detection on port 3
ACD_EN2	5	R/W	Enable AC disconnect detection on port 2
ACD_EN1	4	R/W	Enable AC disconnect detection on port 1
DCD_EN4	3	R/W	Enable DC disconnect detection on port 4
DCD_EN3	2	R/W	Enable DC disconnect detection on port 3
DCD_EN2	1	R/W	Enable DC disconnect detection on port 2
DCD_EN1	0	R/W	Enable DC disconnect detection on port 1

Setting DET\_EN\_/CLASS\_EN\_ to 1 (Table 18) enables load detection/classification, respectively. Detection always has priority over classification. To perform classification without detection, set the DET\_EN\_ bit low and CLASS\_EN\_ bit high.

In manual mode, R14h works like a pushbutton. Set the bits high to begin the corresponding routine. The bit clears after the routine finishes.

When entering auto mode, R14h defaults to FFh. When entering semi or manual modes, R14h defaults to 00h. A reset or power-up sets R14h = AAAAAAAb where A represents the latched-in state of the AUTO input prior to the reset.

Table 18.	Detection	and Cla	assification	Enable	Register
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ADDRESS = 14h			DESCRIPTION
SYMBOL	BIT	R/W	DESCRIPTION
CLASS_EN4	7	R/W	Enable classification on port 4
CLASS_EN3	6	R/W	Enable classification on port 3
CLASS_EN4	5	R/W	Enable classification on port 2
CLASS_EN3	4	R/W	Enable classification on port 1
DET_EN4	3	R/W	Enable detection on port 4
DET_EN3	2	R/W	Enable detection on port 3
DET_EN2	1	R/W	Enable detection on port 2
DET_EN1	0	R/W	Enable detection on port 1

CL\_DISC (R17h[2]) and ENx\_CL6 (R1Ch[7:4]) are used to program the high-power mode. See Table 3 for details. Setting BCKOFF\_ to 1 (Table 19) enables cadence timing on each port where the port backs off and waits 2.2s after each failed load discovery detection. The IEEE 802.3af standard requires a PSE that delivers power through the spare pairs (midspan PSE) to have cadence timing.

A reset or power-up sets R15h = 0000XXXXb where 'X' is the logic AND of the MIDSPAN and AUTO inputs.

Table 19	Backoff	and	<b>High-Power</b>	Enable	Register
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ADDRE	ESS = 15h		DECODIDITION
SYMBOL	BIT	R/W	DESCRIPTION
BCKOFF4	3	R/W	Enable cadence timing on port 4
BCKOFF3	2	R/W	Enable cadence timing on port 3
BCKOFF2	1	R/W	Enable cadence timing on port 2
BCKOFF1	0	R/W	Enable cadence timing on port 1

TSTART[1,0] (Table 20a) programs the startup timers. Startup time is the time the port is allowed to be in current limit during startup. TFAULT[1,0] programs the fault time. Fault time is the time allowed for the port to be in current limit during normal operation. RSTR[1,0] programs the discharge rate of the TFAULT\_ counter and effectively sets the time the port remains off after an overcurrent fault. TDISC[1,0] programs the load disconnect detection time. The device turns off power to the port if it fails to provide a minimum power maintenance signal for longer than the load disconnect detection time (TDISC). Set the bits in R16h to scale the tSTART, tFAULT, and tDISC to a multiple of their nominal value specified in the *Electrical Characteristics* table.

When the MAX5952 shuts down a port due to an extended overcurrent condition (either during startup or normal operation), if RSTR\_EN is set high, the part does not allow the port to power back on before the restart timer (Table 20b) returns to zero. This effectively sets a minimum duty cycle that protects the external MOSFET from overheating during a prolonged output overcurrent conditions. A reset sets R16h = 00h.

ADDRE	SS = 16h		DESCRIPTION
SYMBOL	BIT	R/W	DESCRIPTION
RSTR[1]	7	R/W	Restart timer programming bit 1
RSTR[0]	6	R/W	Restart timer programming bit 0
TSTART[1]	5	R/W	Startup timer programming bit 1
TSTART[0]	4	R/W	Startup timer programming bit 0
TFAULT[1]	3	R/W	Overcurrent timer programming bit 1
TFAULT[0]	2	R/W	Overcurrent timer programming bit 0
TDISC[1]	1	R/W	Load disconnect timer programming bit 1
TDISC[0]	0	R/W	Load disconnect timer programming bit 0

## Table 20a. Timing Register

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## Table 20b. Startup, Fault, and Load Disconnect Timer Values for Timing Register

BIT [1:0] (ADDRESS = 16h)	RSTR	tDISC	tstart	<sup>t</sup> FAULT
00	16 x tfault	tDISC nominal (350ms, typ)	tstart nominal (60ms, typ)	tFAULT nominal (60ms, typ)
01	32 x t <sub>FAULT</sub>	1/4 x t <sub>DISC</sub> nominal	1/2 x tSTART nominal	1/2 x tFAULT nominal
10	64 x tfault	1/2 x t <sub>DISC</sub> nominal	2 x t <sub>START</sub> nominal	2 x t <sub>FAULT</sub> nominal
11	0 x t <sub>FAULT</sub>	2 x t <sub>DISC</sub> nominal	4 x t <sub>START</sub> nominal	4 x t <sub>FAULT</sub> nominal

Setting CL\_DISC to 1 (Table 21) enables port over class current protection, where MAX5952 scales down the overcurrent limit (VFLT\_LIM) according to the port classification status. This feature provides protection to the system against PDs that violate their maximum class current allowance.

The higher current setting is enabled only after a successful startup so that the PD powers up as a normal 15W device.

CL\_DISC, together with EN\_HP\_CL\_ (R15h[6:4]), EN\_HP\_ALL (R15h[7]), and ENx\_CL6 (R1Ch[7:4]) are used to program the high-power mode. See Table 3 for details.

Setting OUT\_ISO high (Table 21), forces DET\_ to a high-impedance state.

A reset sets R17h = 0xC0.

ADDRESS = 17h			DESODIDITION
SYMBOL	BIT	R/W	DESCRIPTION
INT_EN	7	R/W	A logic-high enables INT functionality
RSTR_EN	6	R	A logic-high enables the autorestart protection time off (as set by the RSTR[1:0] bits)
Reserved	5	R	Reserved
Reserved	4	R	Reserved
POFF_CL	3	R	A logic-high prevents power-up after a classification failure (I > 50mA, valid only in AUTO mode)
CL_DISC	2	R/W	A logic-high enables reduced current-limit voltage threshold (VFLT_LIM) according to port
OUT_ISO	1	R/W	Forces DET_ to high impedance. Does not interfere with other circuit operation.

## Table 21. Miscellaneous Configurations 1

Power-enable pushbutton for semi and manual modes is found in Table 22. Setting PWR\_ON\_ to 1 turns on power to the corresponding port. Setting PWR\_OFF\_ to 1 turns off power to the port. PWR\_ON\_ is ignored when the port is already powered and during shutdown. PWR\_OFF\_ is ignored when the port is already off and during shutdown. After execution, the bits reset to 0. During detection or classification, if  $PWR_ON_goes$  high, the MAX5952 gracefully terminates the current operation and turns on power to the port. The MAX5952 ignores the PWR\_ON\_ in auto mode. A reset sets R19h = 00h.

## Table 22. Power-Enable Pushbuttons

ADDRESS = 19h			DECODIDITION	
SYMBOL	BIT	R/W	DESCRIPTION	
PWR_OFF4	7	W	A logic-high powers off port 4	
PWR_OFF3	6	W	A logic-high powers off port 3	
PWR_OFF2	5	W	A logic-high powers off port 2	
PWR_OFF1	4	W	A logic-high powers off port 1	
PWR_ON4	3	W	A logic-high powers on port 4	
PWR_ON3	2	W	A logic-high powers on port 3	
PWR_ON2	1	W	A logic-high powers on port 2	
PWR_ON1	0	W	A logic-high powers on port 1	

Writing a 1 to CLR\_INT (Table 23) clears all the event registers and the corresponding interrupt bits in register R00h. Writing a 1 to RESET\_P\_ turns off power to the corresponding port and resets only the status and

event registers of that port. After execution, the bits reset to 0. Writing a 1 to RESET\_IC causes a global software reset, after which the register map is set back to its reset state. A reset sets R1Ah = 00h.

## Table 23. Global Pushbuttons

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ADDRESS = 1Ah			DESCRIPTION
SYMBOL	BIT	R/W	DESCRIPTION
CLR_INT	7	W	A logic-high clears all interrupts
Reserved	6		Reserved
Reserved	5		Reserved
RESET_IC	4	W	A logic-high resets the MAX5952
RESET_P4	3	W	A logic-high softly resets port 4
RESET_P3	2	W	A logic-high softly resets port 3
RESET_P2	1	W	A logic-high softly resets port 2
RESET_P1	0	W	A logic-high softly resets port 1

The ID register (Table 24) keeps track of the device ID number and revision. The MAX5952's ID\_CODE[4:0] = 11000b. Contact the factory for REV[2:0] value.

## Table 24. ID Register

ADDRESS = 1Bh			DESCRIPTION	
SYMBOL	BIT	R/W	DESCRIPTION	
	7	R	ID_CODE[4]	
ID_CODE	6	R	ID_CODE[3]	
	5	R	ID_CODE[2]	
	4	R	ID_CODE[1]	
	3	R	ID_CODE[0]	
REV	2	R	REV [2]	
	1	R	REV [1]	
	0	R	REV [0]	

Enable the SMODE function (Table 25) by setting EN\_WHDOG (R1Fh[7]) to 1. SMODE\_ bit goes high when the watchdog counter reaches zero and the port(s) switch over to hardware-controlled mode.

SMODE\_ also goes high each and every time the software tries to power on a port, but is denied since the port is in hardware mode. A reset sets R1Ch = 00h.

ADDRESS = 1Ch			DECODIDITION	
SYMBOL	BIT	CoR	DESCRIPTION	
SMODE4	3	CoR	Port 4 hardware control flag	
SMODE3	2	CoR	Port 3 hardware control flag	
SMODE2	1	CoR	Port 2 hardware control flag	
SMODE1	0	CoR	Port 1 hardware control flag	

## Table 25. SMODE Enable Register

Set EN\_WHDOG (R1Fh[7]) to 1 to enable the watchdog function. When activated, the watchdog timer counter, WDTIME[7:0], continuously decrements toward zero once every 164ms. Once the counter reaches zero (also called watchdog expiry), the MAX5952 enters hardware-controlled mode and each port shifts to a mode set by the HWMODE\_ bit in register R1Fh (Table 27). Use software to set WDTIME (Table 26) and continuously set this register to some nonzero value before

the register reaches zero to prevent a watchdog expiry. In this way, the software gracefully manages the power to ports upon a system crash or switchover.

While in hardware-controlled mode, the MAX5952 ignores all requests to turn the power on and the flag SMODE\_ indicates that the hardware has taken control of the MAX5952 operation. In addition, the software is not allowed to change the mode of operation in hardware-controlled mode. A reset sets R1Eh = 00h.

ADDRESS = 1Eh			DESCRIPTION	
SYMBOL	BIT	R/W	DESCRIPTION	
	7	R/W	WDTIME[7]	
	6	R/W	WDTIME[6]	
	5	R/W	WDTIME[5]	
	4	R/W	WDTIME[4]	
	3	R/W	WDTIME[3]	
	2	R/W	WDTIME[2]	
	1	R/W	WDTIME[1]	
	0	R/W	WDTIME[0]	

## Table 26. Watchdog Register

Setting EN\_WHDOG (Table 27) high activates the watchdog counter. When the counter reaches zero, the port switches to the hardware-controlled mode determined by the corresponding HWMODE\_ bit. A low in HWMODE\_ switches the port into shutdown by setting

the bits in register R12h to 00. A high in HWMODE\_ switches the port into auto mode by setting the bits in register R12h to 11. If WD\_INT\_EN is set, an interrupt is sent if any of the SMODE bits are set. A reset sets R1Fh = 00h.

ADDRESS = 1Fh			DECODIDITION
SYMBOL	BIT	R/W	DESCRIPTION
EN_WHDOG	7	R/W	A logic-high enables the watchdog function
WD_INT_EN	6	R/W	Enables interrupt on SMODE_ bits
Reserved	5		Reserved
Reserved	4	R/W	Reserved
HWMODE4	3	R/W	Port 4 switches to AUTO if logic-high and to SHUTDOWN if logic-low when watchdog timer expires
HWMODE3	2	R/W	Port 3 switches to AUTO if logic-high and to SHUTDOWN if logic-low when watchdog timer expires
HWMODE2	1	R/W	Port 2 switches to AUTO if logic-high and to SHUTDOWN if logic-low when watchdog timer expires
HWMODE1	0	R/W	Port 1 switches to AUTO if logic-high and to SHUTDOWN if logic-low when watchdog timer expires

## Table 27. Switch Mode Register

The CLC\_EN enables the large capacitor detection feature. When CLC\_EN is set the device can recognize a capacitor load up to  $100\mu$ F. If the CLC\_EN is reset, the MAX5952 performs normal detection.

AC\_TH allows programming of the threshold of the AC disconnect comparator. The threshold is defined as a current since the comparators verify that the peak of the current pulses sensed at the DET\_ input exceed a preset threshold. The current threshold is defined as follows:

 $IAC_TH = 226.68\mu A + 28.33 \times NAC_TH$ 

where NAC\_TH is the decimal value of AC\_TH.

When set low, DET\_BY inhibits port power-on if the discovery detection was bypassed in auto mode. When set high, DET\_BY allows the device to turn on power to a non-IEEE 802.3af load without doing detection. If OSCF\_RS is set high, the OSC\_FAIL bit is ignored. A reset or power-up sets R23h = 04h. Default IAC\_TH is  $340\mu$ A.

Table	28.	Program	Register
-------	-----	---------	----------

ADDRESS = 23h			DESCRIPTION
SYMBOL	BIT	R/W	DESCRIPTION
Reserved	7	—	Reserved
Reserved	6	_	Reserved
CLC_EN	5	R/W	Large capacitor detection enable
DET_BY	4	R/W	Enables skipping detection in AUTO mode
OSCF_RS	3	R/W	OSC_FAIL reset bit
	2	R/W	AC_TH[2]
AC_TH	1	R/W	AC_TH[1]
	0	R/W	AC_TH[0]

## Table 29. High-Power Mode Register

ADDRESS = 24h			DESCRIPTION					
SYMBOL	BIT	R/W	DESCRIPTION					
	7	_	Reserved					
	3		Reserved					
Reserved	2		Reserved					
	1	_	Reserved					
	0	_	Reserved					

# **MAX5952**

## Table 30. Reserved

ADDRESS = 25h			DESCRIPTION					
SYMBOL	BIT	R/W	DESCRIPTION					
	7		Reserved					
	6		Reserved					
	5		Reserved					
Deserved	4		Reserved					
Reserved	3		Reserved					
	2		Reserved					
	1		Reserved					
	0	_	Reserved					

## Table 31. Reserved

ADDRESS = 26h			DESCRIPTION					
SYMBOL	BIT	R/W	DESCRIPTION					
	7	_	Reserved					
	6		Reserved					
	5	_	Reserved					
Decement	4	_	Reserved					
Reserved	3	—	Reserved					
	2	_	Reserved					
	1	_	Reserved					
	0		Reserved					

The IVEE bits enable the current-limit scaling (Table 32). This feature is used to reduce the current limit for systems running at higher voltage to maintain the

Table 32. Miscellaneous Configurations 2

ADDR	ESS = 291	DESCRIPTION	
SYMBOL	BIT	DESCRIPTION	
	7		Reserved
	6		Reserved
Deserved	5		Reserved
Reserved	4		Reserved
	3	_	Reserved
	2	_	Reserved
	1	R/W	IVEE[1]
	0	R/W	IVEE[0]

The three ICUT\_ bits (Tables 34a and 34b) allow programming of the current-limit and overcurrent thresholds in excess of the IEEE 802.3af standard limit. The MAX5952 can automatically set the ICUT register or can be manually written to by the software (see Table 3).

## Table 34a. ICUT Registers 1 and 2

desired output power. Table 33 sets the current-limit scaling register. A reset or power-up sets R29h = 00h.

IVEE[1:0] (ADDRESS = 29h)	CURRENT LIMIT (%)
00	Default
01	-5
10	-10
11	-15

Table 33.	<b>Current-Lim</b>	it Scaling	Register
	••••••		

Class 1 and 2 limits can also be programmed by software independently from the classification status. See Table 3. A reset or power-up sets R2Ah = R2Bh = 00h.

ADDRESS = 2Ah			DESCRIPTION					
SYMBOL	BIT	R/W	DESCRIPTION					
Reserved	7	_	Reserved					
	6	R/W	ICUT2[2]					
ICUT2	5	R/W	ICUT2[1]					
	4	R/W	ICUT2[0]					
Reserved	3		Reserved					
	2	R/W	ICUT1[2]					
ICUT1	1	R/W	ICUT1[1]					
	0	R/W	ICUT1[0]					

## Table 34b. ICUT Registers 3 and 4

ADDRESS = 2Bh			DESCRIPTION					
SYMBOL	BIT	R/W	DESCRIPTION					
Reserved	7		Reserved					
ICUT4	6	R/W	ICUT4[2]					
	5	R/W	ICUT4[1]					
	4	R/W	ICUT4[0]					
Reserved	3	_	Reserved					
	2	R/W	ICUT3[2]					
ICUT3	1	R/W	ICUT3[1]					
	0	R/W	ICUT3[0]					

## Table 34c. ICUT Register Bit Values for Current-Limit Threshold

ICUT_[2:0] (ADDRESS = 2Ah, 2Bh)	SCALE FACTOR	TYPICAL CURRENT-LIMIT THRESHOLD (mA)
000	1x	375
001	1.5x	563
010	1.75x	656
011	2x	750
100	2.25x	844
101	2.5x	938
110	0.3x	Class 1
111	0.53x	Class 2

## Table 35. Classification Status Registers

ADDRESS = 2Ch, 2Dh, 2Eh, 2Fh		Eh, 2Fh	DESCRIPTION				
SYMBOL	BIT	R/W	DESCRIPTION				
Reserved	7		Reserved				
	6		Reserved				

The MAX5952 provides current readout for each port during classification and normal power mode. The current per port information is separated into 9 bits. They are organized into 2 consecutive registers for each one of the ports. The information can be quickly retrieved using the auto-increment option of the address pointer. To avoid the LSB register changing while reading the MSB, the information is frozen once the addressing byte points to any of the current readout registers. During power mode, the current value can be calculated as

IPORT = NIPD\_ x 1.953125mA

During classification, the current is

## ICLASS = NIPD\_ x 0.0975mA

where N<sub>IPD\_</sub> is the decimal value of the 9-bit word. The ADC saturates both at full scale and at zero. A reset sets R30h–R37h = 00h.

ADDRESS = 30h, 31h, 32h, 33h, 34h, 35h, 36h, 37h			DESCRIPTION						
SYMBOL	BIT	R/W							
	7	W	IPD_[8]						
	6	W	IPD_[7]						
	5	W	IPD_[6]						
חסו	4	W	IPD_[5]						
	3	W	IPD_[4]						
	2	W	IPD_[3]						
	1	W	IPD_[2]						
	0	W	IPD_[1]/IPD_[0]						

## **Table 36. Current Registers**

## Table 37. Register Summary

ADDR	REGISTER NAME	R/W	PORT	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	RESET STATE
INTERR	UPTS											
00h	Interrupt	RO	G	SUP_FLT	TSTR_FLT	IMAX_FLT	CL_END	DET_END	LD_DISC	PG_INT	PE_INT	0000,0000
01h	Int Mask	R/W	G	MASK7	MASK6	MASK5	MASK4	MASK3	MASK2	MASK1	MASK0	AAA0,0A00
EVENTS	EVENTS											
02h	Power Event	RO	4321					PWEN_	PWEN_	PWEN_	PWEN_	0000,0000
03h	Power Event CoR	CoR		PG_CHG4	PG_CHG3	PG_CHG2	PG_CHG1	CHG4	CHG3	CHG2	CHG1	
04h	Detect Event	RO	4321									0000,0000
05h	Detect Event CoR	CoR		GL_END4	CL_END3	GL_END2	CL_ENDI	DEI_END4	DET_ENDS	DET_END2	DET_ENDT	
06h	Fault Event	RO	4321									0000,0000
07h	Fault Event CoR	CoR		LD_DISC4	LD_DISC3	LD_DISC2	LD_DISC I	INAX_FL14	IWAX_FL13	IMAX_FL12	IMAX_FL11	
08h	Tstart Event	RO	4321	11/04	11/00	11/00	11/01					0000,0000
09h	Tstart Event CoR	CoR		1004	1003	1062	IVCI	SIRI_FLI4	SIRI_FLI3	SIRI_FLIZ	SIRI_FLII	
0Ah	Supply Event	RO	4321	TOD								0001,0000*
0Bh	Supply Event CoR	CoR		150	VDD_OV	VDD_UV	VEE_UVLO	VEE_OV	VEE_UV	USC_FAIL	VDD_UVLU	
STATUS	S											
0Ch	Port 1 Status	RO	1	Reserved	CLASS1[2]	CLASS1[1]	CLASS1[0]	Reserved	DET_ST1[2]	DET_ST1[1]	DET_ST1[0]	0000,0000
0Dh	Port 2 Status	RO	2	Reserved	CLASS2[2]	CLASS2[1]	CLASS2[0]	Reserved	DET_ST2[2]	DET_ST2[1]	DET_ST2[0]	0000,0000
0Eh	Port 3 Status	RO	3	Reserved	CLASS3[2]	CLASS3[1]	CLASS3[0]	Reserved	DET_ST3[2]	DET_ST3[1]	DET_ST3[0]	0000,0000
0Fh	Port 4 Status	RO	4	Reserved	CLASS4[2]	CLASS4[1]	CLASS4[0]	Reserved	DET_ST4[2]	DET_ST4[1]	DET_ST4[0]	0000,0000
10h	Power Status	RO	4321	PGOOD4	PGOOD3	PGOOD2	PGOOD1	PWR_EN4	PWR_EN3	PWR_EN2	PWR_EN1	0000,0000
11h	Pin Status	RO	G	Reserved	Reserved	A3	A2	A1	A0	MIDSPAN	AUTO	00A3A2, A1A0MA
CONFIG	URATION											
12h	Operating Mode	R/W	4321	P4_M1	P4_M0	P3_M1	P3_M0	P2_M1	P2_M0	P1_M1	P1_M0	AAAA,AAAA
13h	Disconnect Enable	R/W	4321	ACD_EN4	ACD_EN3	ACD_EN2	ACD_EN1	DCD_EN4	DCD_EN3	DCD_EN2	DCD_EN1	0000,AAAA
14h	Det/Class Enable	R/W	4321	CLASS_EN4	CLASS_EN3	CLASS_EN2	CLASS_EN1	DET_EN4	DET_EN3	DET_EN2	DET_EN1	AAAA,AAAA
15h	Backoff Enable	R/W	4321	_		—		BCKOFF4	BCKOFF3	BCKOFF2	BCKOFF1	0000,XXXX
16h	Timing Config	R/W	G	RSTR[1]	RSTR[0]	TSTART[1]	TSTART[0]	TFAULT[1]	TFAULT[0]	TDISC[1]	TDISC[0]	0000,0000
17h	Misc Config 1	R/W	G	INT_EN	RSTR_EN	Reserved	Reserved	POFF_CL	CL_DISC	OUT_ISO	HP_TIME	1100,0000
PUSHB	UTTONS		-			-						
18h	Reserved	R/W	G	Reserved								
19h	Power Enable	WO	4321	PWR_OFF4	PWR_OFF3	PWR_OFF2	PWR_OFF1	PWR_ON4	PWR_ON3	PWR_ON2	PWR_ON1	0000,0000
1Ah	Global	WO	G	CLR_INT	Reserved	Reserved	RESET_IC	RESET_P4	RESET_P3	RESET_P2	RESET_P1	0000,0000
GENER	AL					-	-	-	-			
1Bh	ID	RO	G	ID_CODE[4]	ID_CODE[3]	ID_CODE[2]	ID_CODE[1]	ID_CODE[0]	REV [2]	REV [1]	REV [0]	1100,0000
1Ch	SMODE Register	CoR	4321	—		—	—	SMODE4	SMODE3	SMODE2	SMODE1	0000,0000
1Dh	Reserved		G	Reserved								
1EH	Watchdog Register	R/W	G	WDTIME[7]	WDTIME[6]	WDTIME[5]	WDTIME[4]	WDTIME[3]	WDTIME[2]	WDTIME[1]	WDTIME[0]	0000,0000
1FH	Switch Mode Register	R/W	4321	EN_WHDOG	WD_INT_EN	reserved	CSCM	HWMODE4	HWMODE3	HWMODE2	HWMODE1	0000,0000

ADDR	REGISTER NAME	R/W	PORT	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	RESET STATE
MAXIM	RESERVED											
20H	Reserved		G	Reserved								
21H	Reserved		G	Reserved								
22H	Reserved		G	Reserved								
23H	Program 1	R/W	4321	Reserved	Reserved	CLC_EN	DET_BY	OSCF_RS	AC_TH[2]	AC_TH[1]	AC_TH[0]	0000,0000
24h	High Power Mode	R/W	G	Reserved	_	—	—	Reserved	Reserved	Reserved	Reserved	0000,0000
25h	Reserved	_	G	Reserved	0000,0000							
26h	Reserved	_	G	Reserved	0000,0000							
27H	Reserved		G	Reserved								
28H	Reserved		G	Reserved								
29H	Misc Config 2	R/W	1234	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	IVEE[1]	IVEE[0]	0000,0000
2AH	ICUT Register 1	R/W	21	Reserved	ICUT2[2]	ICUT2[1]	ICUT2[0]	Reserved	ICUT1[2]	ICUT1[1]	ICUT1[0]	0000,0000
2BH	ICUT Register 2	R/W	43	Reserved	ICUT4[2]	ICUT4[1]	ICUT4[0]	Reserved	ICUT3[2]	ICUT3[1]	ICUT[30]	0000,0000
CLASS	IFICATION REGISTER	S										
2CH	Port 1 Class	RO	1	Reserved	Reserved	—	—	—	—		—	0000,0000
2DH	Port 2 Class	RO	2	Reserved	Reserved	—	_	—	_		_	0000,0000
2EH	Port 3 Class	RO	3	Reserved	Reserved	—	—	—	_	_	—	0000,0000
2FH	Port 4 Class	RO	4	Reserved	Reserved	—	—	—	_	_	—	0000,0000
CURRE	NT REGISTER						-		-		-	
30H	Current Port 1 (MSB)	RO	1	IPD1[8]	IPD1[7]	IPD1[6]	IPD1[5]	IPD1[4]	IPD1[3]	IPD1[2]	IPD1[1]	0000,0000
31H	Current Port 1 (LSB)	RO	1	Reserved	IPD1[0]	0000,0000						
32H	Current Port 2 (MSB)	RO	2	IPD2[8]	IPD2[7]	IPD2[6]	IPD2[5]	IPD2[4]	IPD2[3]	IPD2[2]	IPD2[1]	0000,0000
33H	Current Port 2 (LSB)	RO	2	Reserved	IPD2[0]	0000,0000						
34H	Current Port 3 (MSB)	RO	3	IPD3[8]	IPD3[7]	IPD3[6]	IPD3[5]	IPD3[4]	IPD3[3]	IPD3[2]	IPD3[1]	0000,0000
35H	Current Port 3 (LSB)	RO	3	Reserved	IPD3[0]	0000,0000						
36H	Current Port 4 (MSB)	RO	4	IPD4[8]	IPD4[7]	IPD4[6]	IPD4[5]	IPD4[4]	IPD4[3]	IPD4[2]	IPD4[1]	0000,0000
37H	Current Port 4 (LSB)	RO	4	Reserved	IPD4[0]	0000,0000						

## Table 37. Register Summary (continued)

\*UV and UVLO bits of VEE and VDD asserted depends on the order VEE and VDD supplies are brought up.

A = AUTO pin state before reset.

*M* = *MIDSPAN* state before reset.

A3...0 = ADDRESS input states before reset.

#### **Applications Information** RJ-45 CONNECTOR RD1+ RX1+ -01 RX1--02 3 RD1-1/2 OF 21 PHY TX1--0.3 H2005A TD1+\* 19 TX1-**•**6 TD1--48VOUT 0.1uF 75Ω 0.1uF 75Ω RXT1 W -05 1000pF 250VAC 0.1µF 0.1µF $75\Omega$ 750 $\sim$ TXCT1 ιΛΛ. -08 -48VRTN O-Vdd ISOLATION <u>+</u> V<sub>CC</sub> (3.3V) 1.8V TO 5V, ò (REF TO DGND) AGND AO A1 A2 A3 0 V<sub>DD</sub> ≥ 1kΩ 180Ω 3kΩ RESET INTERNAL 50kΩ PULLUP $\geq$ 3kΩ 4.7kΩ HPCL063L VCCRTN INT SDAOUT 0 INTERNAL PULLDOWN SERIAL INTERFACE OPTIONAL BUFFER AUTO (MANUAL MODE) 3kΩ 180Ω $\sim$ INTERNAL PULLDOWN MIDSPAN /M/IXI/M SDAIN (SIGNAL MODE) MAX5952 OSC\_IN HPCL063L SDA SINE WAVE 100Hz ±10% OPTIONAL BUFFER PEAK AMPLITUDE 2.2V ±0.1V <sup>3kΩ</sup> 180Ω VALLEY AMPLITUDE 0.2V ±0.1V $\langle \Lambda \rangle$ SCL 0N HPCL063L SHD\_ SCL OFF OPTIONAL BUFFER DGND VEE SENSE\_ GATE OUT DET 1kΩ $\leq 100\Omega$ + SMBJ 58CA = Ŵ $0.1\mu F \lesssim 2.2M\Omega$ 0.47µF 0.5Ω **1**N4448 -48VOUT 100V 1% | ▲ -48V O 1N4002 FDT3612 100V, 120m $\Omega$ SOT-223 \*USE HALO TG111-HRPE40NY OR PULSE HX6015NL FOR HIGH POWER 1 OF 4 CHANNELS

Figure 13. PoE System Block Diagram

**MAX5952** 



Figure 14. PoE System Block Diagram

**MAX5952** 





Figure 15. -48V to +3.3V (300mA) Boost Converter Solution for VDIG



Figure 16. Layout Example for Boost Converter Solution for VDIG

DESIGNATION	DESCRIPTION
C1	0.1µF, 25V ceramic capacitor
C2	0.022µF, 25V ceramic capacitor
C3	15nF, 25V ceramic capacitor
C4	220µF capacitor Sanyo 6SVPA220MAA
C5	4.7µF, 16V ceramic capacitor
C6	0.47µF, 100V ceramic capacitor
C7	0.22µF, 16V ceramic capacitor
C8	2.2µF, 16V ceramic capacitor
C9	4.7nF, 16V ceramic capacitor
D1	B1100 100V Schottky diode
L1	68µH inductor Coilcraft DO3308P-683 or equivalent

## Component List for VDIG Supply

DESIGNATION	DESCRIPTION
Q1	Si2328DS Vishay n-channel MOSFET, SOT23
Q2, Q3, Q4	MMBTA56 small-signal PNP
R1, R3	2.61k $\Omega$ ±1% resistors
R2	6.81k $\Omega$ ±1% resistor
R4, R6, R9	1 $\Omega$ ±1% resistors
R5	1k $\Omega$ ±1% resistor
R7	1.02k $\Omega$ ±1% resistor
R8	$30\Omega \pm 1\%$ resistor
R10	$2\Omega \pm 1\%$ resistor
U1	High-voltage PWM IC MAX5020ESA (8-pin SO)



TOP VIEW		
RESET 1	+	36 OSC
MIDSPAN 2		35 AUTO
INT 3		34 OUT1
SCL 4		33 GATE1
SDAOUT 5		32 SENSE1
SDAIN 6	IVIAAJ9J2	31 OUT2
A3 7		30 GATE2
A2 8		29 SENSE2
A1 9		28 V <sub>EE</sub>
A0 10		27 OUT3
DET1 11		26 GATE3
DET2 12		25 SENSE3
DET3 13		24 OUT4
DET4 14		23 GATE4
DGND 15		22 SENSE4
V <sub>DD</sub> 16		21 AGND
SHD1 17		20 SHD4
SHD2 18		19 SHD3
	SSOP	

## Pin Configuration

PART	SENSE RESISTOR ( $\Omega$ )	V <sub>DD</sub> (V)
MAX5952A_	0.5	3.3
MAX5952C_	0.5	5

**Typical Operating Circuits** -48V RTN OUTPUT TO PORT -48VRTN O ISOLATION V<sub>DD</sub> V<sub>CC</sub> (3.3V) -1.8V TO 3.7V, (REF TO DGND) AGND A0 A1 A2 A3 Ο Vdd 180Ω 3kΩ 1kΩ RESET 3kO INTERNAL  $4.7 k\Omega$  $50k\Omega$  PULLUP SDAOUT INT SERIAL INTERFACE HPCL063L OPTIONAL BUFFER 3kΩ INTERNAL PULLDOWN 180Ω AUTO  $\sim$ (MANUAL MODE)  $\sim$ SDAIN M/XX/// INTERNAL PULLDOWN MAX5952 MIDSPAN HPCL063L (SIGNAL MODE) SDA - N.C. OPTIONAL BUFFER OSC\_IN 3kΩ 180**Ω**  $\sim$  $\Lambda \Lambda /$ SCL ON HPCL063L SHD SCL OFF -**OPTIONAL BUFFER** DGND Ŧ  $V_{\text{EE}}$ SENSE\_ GATE. OUT DET  $\leq$ -48V 100Ω 👗 1N4448  $0.5\Omega$ OUTPUT TO 1% PORT 4 -48V O-FDT3612 100V, 120m $\Omega$ SOT-223 NOTE: ALL SIGNAL PINS ARE REFERENCED TO DGND. DGND RANGE IS BETWEEN VEE AND (AGND + 4V). CAN BE UP TO  $100k\Omega$ 1 OF 4 CHANNELS



**MAX5952** 



## \_Typical Operating Circuits (continued)

Typical Operating Circuit 2 (with AC Load Removal Detection)

**Chip Information** 

PROCESS: BICMOS

## **Package Information**

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing per-tains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
36 SSOP	A36-4	<u>21-0040</u>

table, and Detailed Description.

**MAX5952** 

REVISION NUMBER

1

1/10

		-
REVISION DATE	DESCRIPTION	PAGES CHANGED
7/07	Initial release	_
1/10	Revised the General Description, Features, Electrical Characteristics	

**Revision History** 

1, 7, 15

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